

High Current, High Speed LDO Regulators, Voltage Detector Function

■ GENERAL DESCRIPTION

The XC6402 series are precise, low noise, high current, positive voltage low dropout regulators with built-in voltage detector. They are fabricated using Torex's CMOS process. The series features a voltage reference, an error amplifier, a current limiter, a voltage detector and a phase compensation circuit plus a driver transistor.

The output voltage of the LDO and detect voltage of the detector is selectable in 50mV increments within the range of 0.8V to 5.0V. With a low ON resistance driver transistor built-in, batteries can be used until input-output voltage differential is minimal and can accordingly be used for a longer time.

The series is also compatible with low ESR ceramic capacitors which give added output stability. The series provides options to the user to select from a variety of circuit features, such as detector monitoring, detector output logic, EN pin input logic, and internal pull-up / down resistance (semi-custom). The IC's internal regulator circuit can be placed in stand-by mode via the EN function (XC6402C series). In the stand-by mode, power consumption is greatly reduced. The XC6402F series offers the option of a delay on the detector output: the delay time can be controlled by the use of an external capacitor.

■ APPLICATIONS

- CD-ROM, CD-R / RW drive
- DVD drive
- HDD drive
- Cameras, Video recorders
- Portable AV equipment
- Battery powered equipment

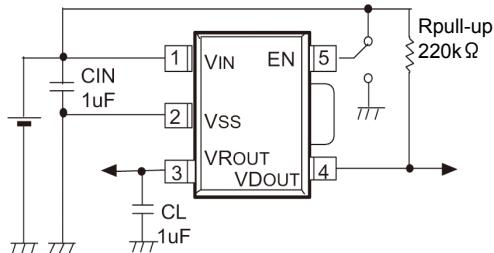
■ FEATURES

Maximum Output Current	: More than 700mA (800mA limit) $(1.6V \leq V_{ROUT(T)} \leq 5.0V)$
Dropout Voltage	: 50mV @ 100mA 100mV @ 200mA
Maximum Operating Voltage	: 1.5V ~ 6.0V
VR Output Voltage Range	: 0.8V ~ 5.0V (50mV increments)
VD Detect Voltage Range	: 0.8V ~ 5.0V (50mV increments) More than 1.5V (V_{IN} sensing)
Highly Accurate	: $\pm 2\%$
Low Power Consumption	: 35 μA (TYP.)
High Ripple Rejection	: 60dB @ 1kHz
Ambient Temperature	: - 40°C ~ 85°C
Low ESR Capacitor	: Ceramic capacitor compatible
Ultra Small Packages	: SOT-25, SOT-89-5, USP-6B,

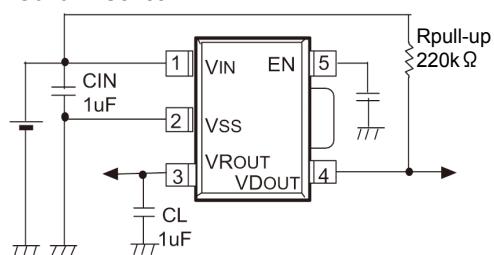
* VD: Voltage Detector

■ TYPICAL APPLICATIONS CIRCUITS

● XC6402C Series

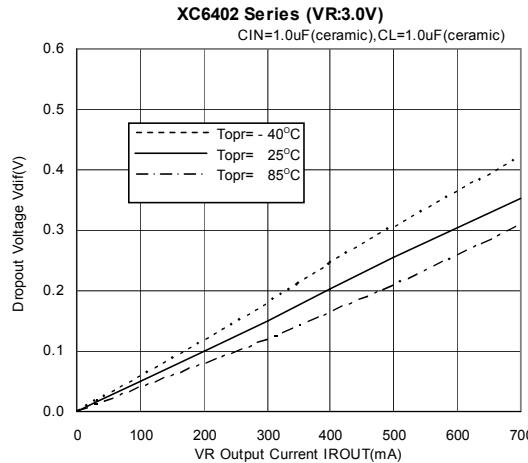


● XC6402F Series

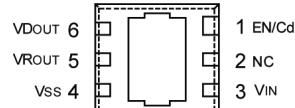
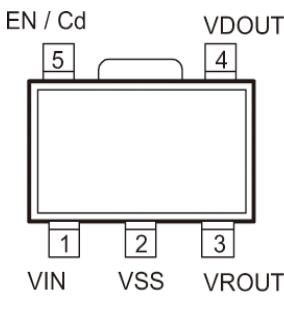
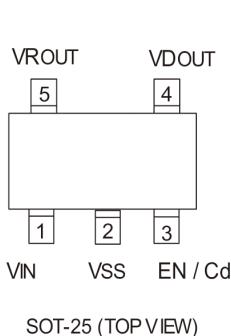


■ TYPICAL PERFORMANCE CHARACTERISTICS

● Dropout Voltage vs. VR Output Current



■ PIN CONFIGURATION



USP-6B (BOTTOM VIEW)

*The dissipation pad for the USP-6B package should be solder-plated in recommended mount pattern and metal masking so as to enhance mounting strength and heat release.
If the pad needs to be connected to other pins, it should be connected to the Vss pin.

■ PIN ASSIGNMENT

PIN NUMBER			PIN NAME	FUNCTION
SOT-25	SOT-89-5	USP-6B		
1	1	3	VIN	Power Input
2	2	4	Vss	Ground
5	3	5	VRROUT	VR Output
4	4	6	VDOUT	VD Output
3	5	1	EN	VR ON/OFF Control (C Series)
3	5	1	Cd	Delay Capacitor Connection (F Series)
-	-	2	NC	No Connection

■ PRODUCT CLASSIFICATION

● Selection Guide

1. EN Input Logic, Internal Pull-up / down as option

SERIES	CE INPUT LOGIC
XC6402 * A ~ D	High Active with pull-down resistance
XC6402 * E ~ K	High Active with no pull-down resistance
XC6402 * L ~ P	Low Active with pull-up resistance
XC6402 * R ~ U	Low Active with no pull-up resistance

2. VD Sense as option

SERIES	VD SENSE PIN
XC6402 * A, B, E, F, L, M, R, S, V, X	VIN
XC6402 * C, D, H, K, N, P, T, U, Y, Z	VROUT

3. VD Output Logic as option

SERIES	VD OUTPUT LOGIC
XC6402 * A, C, E, H, L, N, R, T, V, Y	Detect L
XC6402 * B, D, F, K, M, P, S, U, X, Z	Detect H

■ PRODUCT CLASSIFICATION (Continued)

● Ordering Information

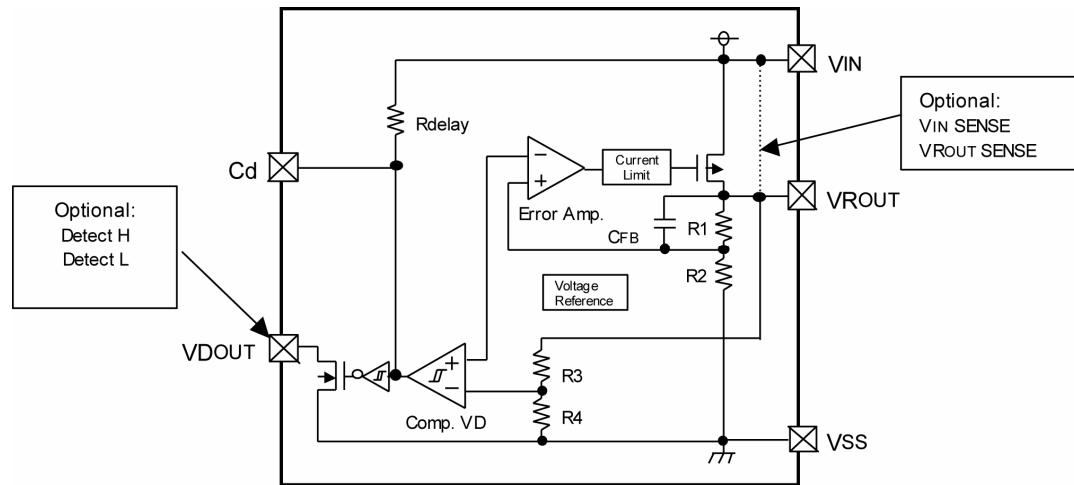
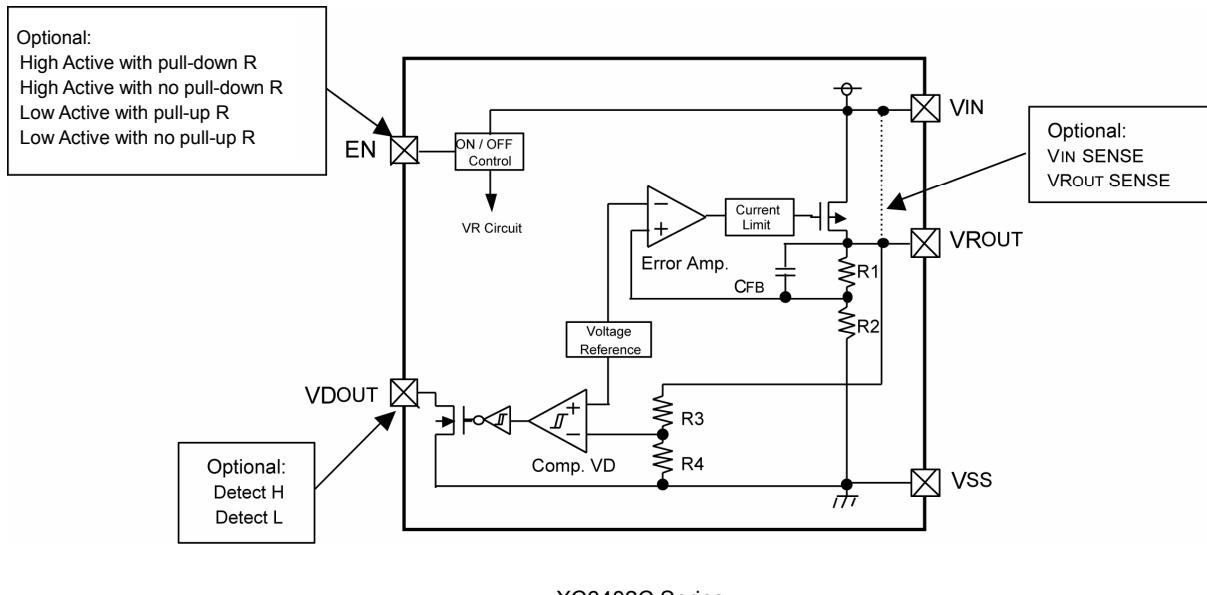
XC6402 ①②③④⑤⑥

DESIGNATOR	DESCRIPTION	SYMBOL	DESCRIPTION
①	Operational Function	C	: EN function
		F	: Cd Pin
②	Type of Regulator	-	: As in the chart below
③ ④	Output Voltage & Detect Voltage	-	: Internally set sequential number relating to output voltage and detect voltage. VR setting output voltage range: 0.8V ~ 5.0V Detect voltage setting range: 0.8V ~ 5.0V 50mV increments are available
⑤	Package	M	: SOT-25 (SOT-23-5)
		P	: SOT-89
		D	: USP-6B
⑥	Device Orientation	R	: Embossed tape, standard feed
		L	: Embossed tape, reverse feed

PIN NUMBER : ② Types

②	EN FUNCTION	EN LOGIC	PULL UP/DOWN RESISTANCE	VD SENSE PIN	VD OUTPUT LOGIC	PIN NUMBER ①
A	Functional	High Active	Pull-down Function	VIN	Detect L	C Series
B	Functional	High Active	Pull-down Function	VIN	Detect H	
C	Functional	High Active	Pull-down Function	VROUT	Detect L	
D	Functional	High Active	Pull-down Function	VROUT	Detect H	
E	Functional	High Active	Nonfunctional	VIN	Detect L	
F	Functional	High Active	Nonfunctional	VIN	Detect H	
H	Functional	High Active	Nonfunctional	VROUT	Detect L	
K	Functional	High Active	Nonfunctional	VROUT	Detect H	
L	Functional	Low Active	Pull-up Function	VIN	Detect L	
M	Functional	Low Active	Pull-up Function	VIN	Detect H	
N	Functional	Low Active	Pull-up Function	VROUT	Detect L	
P	Functional	Low Active	Pull-up Function	VROUT	Detect H	
R	Functional	Low Active	Nonfunctional	VIN	Detect L	
S	Functional	Low Active	Nonfunctional	VIN	Detect H	
T	Functional	Low Active	Nonfunctional	VROUT	Detect L	
U	Functional	Low Active	Nonfunctional	VROUT	Detect H	
V	Nonfunctional	-	-	VIN	Detect L	F Series
X	Nonfunctional	-	-	VIN	Detect H	
Y	Nonfunctional	-	-	VROUT	Detect L	
Z	Nonfunctional	-	-	VROUT	Detect H	

■ BLOCK DIAGRAMS



■ ABSOLUTE MAXIMUM RATINGS

Ta = 25°C

PARAMETER	SYMBOL	RATINGS	UNITS
Input Voltage	VIN	6.5	V
VR Output Current	IROUT	800	mA
VR Output Voltage	VROUT	Vss -0.3 ~ VIN +0.3	V
VD Output Current	IDOUT	50	mA
VD Output Voltage	VDOUT	Vss -0.3 ~ 6.5	V
VEN / Cd Pin Voltage	VEN / Cd	Vss -0.3 ~ VIN + 0.3	V
Power Dissipation	SOT-25	Pd	250
	SOT-89-5		500
	USP-6B		100
Operating Temperature Range	Topr	- 40 ~ + 85	°C
Storage Temperature Range	Tstg	- 55 ~ + 125	°C

■ ELECTRICAL CHARACTERISTICS

XC6402C Series

Ta=25°C

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS	CIRCUIT
Output Voltage (*2, 3)	VROUT(E)	VIN=VROUT(T)+1.0V, IROUT=30mA	× 0.98 (-30m)	VROUT(T)	× 1.02 (+30mV)	V	①
Maximum Output Current [VROUT(E) ≥ 1.6V]	IROUTMAX	VIN=VROUT(T)+1.0V VEN=ON(VIN or Vss)	700	-	-	mA	①
Maximum Output Current [VROUT(E) < 1.6V]	IROUTMAX	VIN=VROUT(T)+1.0V VEN=ON(VIN or Vss)	500	-	-	mA	①
Load Regulation	ΔVROUT	1mA ≤ IROUT ≤ 100mA	-	15	60	mV	①
Dropout Voltage (*4)	Vdif1	IROUT=30mA	E-1			mV	①
	Vdif2	IROUT=100mA	E-2				
Supply Current (CA/CB/CC/CD type)	IDD	VEN=VIN=VROUT(T)+1.0V, IROUT=0mA	E-3			μA	②
Supply Current (CL/CM/CN/CP type)	IDD	VEN=VROUT(T)+1.0V, VIN=Vss, IROUT=0mA	E-3			μA	②
Supply Current (CE/CF/CH/CK type)	IDD	VEN=VIN=VROUT(T)+1.0V, IROUT=0mA	-	35	70	μA	②
Supply Current (CR/CS/CT/CU type)	IDD	VEN=VROUT(T)+1.0V, VIN=Vss, IROUT=0mA	-	35	70	μA	②
Line Regulation	$\frac{\Delta VROUT}{\Delta VIN \cdot VROUT}$	VROUT(T)+1.0V ≤ VIN ≤ 6.0V VEN=ON(VIN or Vss), IROUT=30mA	-	0.01	0.20	%/V	①
Input Voltage	VIN		1.5	-	6.0	V	-
Output Voltage Temperature Characteristics	$\frac{\Delta VROUT}{\Delta Topr \cdot VROUT}$	IROUT=30mA -40°C ≤ Topr ≤ 85°C	-	±100	-	ppm / °C	①
Ripple Rejection Rate	PSRR	VIN=[VROUT(T)+1.0]VDC+0.5V _{p-pAC} When VROUT(T) ≥ 4.75V → VIN=5.75V+0.5V _{p-pAC} IROUT=30mA, f=1kHz	-	60	-	dB	③
Current Limiter [VROUT(E) ≥ 1.6V]	IRlim	VIN= VROUT(T)+1.0V VEN=ON(VIN or Vss)	700	800	-	mA	①
Current Limiter [VROUT(E) < 1.6V]	IRlim	VIN= VROUT(T)+1.0V VEN=ON(VIN or Vss)	-	800	-	mA	①
Short-Circuit Current	IRshort	VIN= VROUT(T)+1.0V VEN=ON(VIN or Vss)	-	30	-	mA	①

■ ELECTRICAL CHARACTERISTICS (Continued)

XC6402C Series (Continued)

Ta=25°C

	PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS	CIRCUIT
VOLTAGE DETECTOR	Detect Voltage (*7, 8)	VDF(E)		× 0.98 (-30mV)	VDF(T)	× 1.02 (+30mV)	V	④
	Hysteresis Range (*7)	VHYS		VDF(E) × 0.02	VDF(E) × 0.05	VDF(E) × 0.08	V	④
	Supply Current	IDDVD	VEN = OFF (VIN or Vss)	VIN = 1.5V	-	5.0	14.0	μ A
				VIN = 2.0V	-	5.5	14.5	
				VIN = 3.0V	-	6.0	15.0	
				VIN = 4.0V	-	6.5	15.5	
				VIN = 5.0V	-	7.0	16.0	
				VIN = 6.0V	-	7.5	17.0	
	Output Current (*9)	IDOUT	VDOUT = 0.5V	VIN = 1.5V	1.5	3.0	-	mA
				VIN = 2.0V	1.8	3.5	-	
				VIN = 3.0V	1.8	3.7	-	
				VIN = 4.0V	1.9	3.8	-	
				VIN = 5.0V	1.9	3.9	-	
				VIN = 6.0V	2.0	4.0	-	
	Detect Voltage Temperature Characteristics	$\frac{\Delta VDF}{\Delta T_{opr} - VDF}$	-40°C ≤ Topr ≤ 85°C	-	±100	-	ppm / °C	④
SWITCH	EN "High" Level Voltage	VENH		1.30	-	VIN	V	①
	EN "Low" Level Voltage	VENL		-	-	0.25	V	①
	EN "High" Level Current (CA/CB/CC/CD type)	IENH	VEN=VIN=VROUT(T)+1.0V	-0.10	-	E-4	μ A	①
	EN "High" Level Current (CE/CF/CH/CK/CL/CM/CN/CP/CR/CS/CT/CU type)	IENH		-0.10	-	0.10	μ A	①
	EN "High" Level Current (CL/CM/CN/CP type)	IENL	VIN=VROUT(T)+1.0V, VEN=VSS	E-5	-	0.10	μ A	①
	EN "High" Level Current (CA/CB/CC/CD/CE/CF/CH/CK/CR/CS/CT/CU type)	IENL	VIN=VROUT(T)+1.0V, VEN=VSS	-0.10	-	0.10	μ A	①

NOTE:

*1: Unless otherwise stated, VIN=VROUT(T)+1.0V

*2: VROUT(T)=Specified VR output voltage

*3: VROUT(E)=Effective VR output voltage.

(i.e. the VR output voltage when "VROUT(T)+1.0V" is provided at the VIN pin while maintaining a certain IROUT value).

*4: Vdf={VIN⁽⁶⁾ - VROUT⁽⁵⁾}

*5: A voltage equal to 98% of the VR output voltage whenever a stabilized VROUT1=IROUT{VROUT(T)+1.0V} is input.

*6: VIN1=The input voltage when VOUT1, which appears as input voltage is gradually decreased.

*7: VDF(T) : Specified detect voltage value

*8: VDF(E) : Effective detect voltage value.

*9: VD output current value of detect 'L' type equal to current value during detection and that of Detect 'H' type equal to current value before detection.

*10: VROUT(T)≤1.45V, VDF(T)≤1.45V → MIN : VROUT(T)-30mV, VDF(T)-30mV,
→ MAX : VROUT(T)+30mV, VDF(T)+30mV*11: EN conditions: XC6402CZ / CB / CC / CD / CE / CF / CH / CK type: ON=VIN, OFF=Vss
XC6402CL / CM / CN / CP / CR / CS / CT / CU type: ON=Vss, OFF=VIN

*12: VD detect voltage: For VIN sense version, XC6402CA / CB / CE / CF / CL / CM / CR / CS, only VDF(T)≥1.5V type are available.

■ ELECTRICAL CHARACTERISTICS (Continued)

XC6402F Series

T_a=25°C

	PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS	CIRCUIT
VOLTAGE REGULATOR	Output Voltage (*2, 3)	V _{ROUT(E)}	V _{IN} =V _{ROUT(T)} +1.0V, I _{ROUT} =30mA	× 0.98 (-30mV)	V _{ROUT(T)}	× 1.02 (+30mV)	V	①
	Maximum Output Current [V _{ROUT(E)} ≥1.6V]	I _{ROUTMAX}	V _{IN} = V _{ROUT(T)} +1.0V	700	-	-	mA	①
	Maximum Output Current [V _{ROUT(E)} <1.6V]	I _{ROUTMAX}	V _{IN} = V _{ROUT(T)} +1.0V	500	-	-	mA	①
	Load Regulation	ΔV _{ROUT}	1mA≤I _{ROUT} ≤100mA	-	15	60	mV	①
	Dropout Voltage (*4)	V _{dif1}	I _{ROUT} =30mA	E-1			mV	①
		V _{dif2}	I _{ROUT} =100mA	E-2				
	Supply Current	I _{DD}	V _{IN} = V _{ROUT(T)} +1.0V	-	35	70	μA	②
	Line Regulation	$\frac{\Delta V_{ROUT}}{\Delta V_{IN} \cdot V_{ROUT}}$	V _{ROUT(T)} +1.0V≤V _{IN} ≤6.0V I _{ROUT} =30mA	-	0.01	0.20	% / V	①
	Input Voltage	V _{IN}		1.5	-	6.0	V	-
	Output Voltage Temperature Characteristics	$\frac{\Delta V_{ROUT}}{\Delta T_{opr} \cdot V_{ROUT}}$	I _{ROUT} =30mA -40°C≤T _{opr} ≤85°C	-	±100	-	ppm / °C	①
	Ripple Rejection Rate	PSRR	V _{IN} =[V _{ROUT(T)} +1.0]V _{DC} +0.5V _{p-pAC} When V _{ROUT(T)} ≥4.75V → V _{IN} =5.75V+0.5V _{p-pAC} I _{ROUT} =30mA, f=1kHz	-	60	-	dB	③
	Current Limiter [V _{ROUT(E)} ≥1.6V]	I _{RLim}	V _{IN} =V _{ROUT(T)} +1.0V	700	800	-	mA	①
	Current Limiter [V _{ROUT(E)} <1.6V]	I _{RLim}	V _{IN} =V _{ROUT(T)} +1.0V	-	800	-	mA	①
	Short-Circuit Current	I _{Rshort}	V _{IN} =V _{ROUT(T)} +1.0V	-	30	-	mA	①
VOLTAGE DETECTOR	Detect Voltage (*7, 8)	V _{Df(E)}		× 0.98 (-30mV)	V _{Df(T)}	× 1.02 (+30mV)	V	④
	Hysteresis Range (*7)	V _{HYS}		V _{Df(E)} × 0.02	V _{Df(E)} × 0.05	V _{Df(E)} × 0.08	V	④
	Output Current (*9)	I _{DOUT}	V _{DOUT} =0.5V	V _{IN} = 1.5V	-	1.5	3.0	μA
				V _{IN} = 2.0V	-	1.8	3.5	
				V _{IN} = 3.0V	-	1.8	3.7	
				V _{IN} = 4.0V	-	1.9	3.8	
				V _{IN} = 5.0V	-	1.9	3.9	
				V _{IN} = 6.0V	-	2.0	4.0	
	Detect Voltage Temperature Characteristics	$\frac{\Delta V_{DF}}{\Delta T_{opr} \cdot V_{DF}}$	-40°C≤T _{opr} ≤85°C	-	±100	-	ppm / °C	④
	Delay Resistance	R _{delay}	V _{IN} =6.0V, V _{CD} =0V	1.0	2.0	3.5	MΩ	⑥

NOTE:

*1: Unless otherwise stated, V_{IN}=V_{ROUT(T)}+1.0V

*2: V_{ROUT(T)}=Specified VR output voltage

*3: V_{ROUT(E)}=Effective VR output voltage.

(i.e. the VR output voltage when "V_{ROUT(T)}+1.0V" is provided at the V_{IN} pin while maintaining a certain I_{ROUT} value).

*4: V_{dif}={V_{IN1}(*6) - V_{ROUT1}(*5)}

*5: A voltage equal to 98% of the VR output voltage whenever a stabilized V_{ROUT1}=I_{ROUT}{V_{ROUT(T)}+1.0V} is input.

*6: V_{IN1}=The input voltage when V_{OUT1}, which appears as input voltage is gradually decreased.

*7: V_{DF(T)} : Specified detect voltage value

*8: V_{DF(E)} : Effective detect voltage value.

*9: VD output current value of Detect 'L' type equal to current value during detection
and that of Detect 'H' type equal to current value before detection.

*10: V_{ROUT(T)}≤1.45V, V_{DF(T)}≤1.45V
→ MIN: V_{ROUT(T)}-30mV, V_{DF(T)}-30mV,
→ MAX: V_{ROUT(T)}+30mV, V_{DF(T)}+30mV

*11: VD detect voltage: For V_{IN} Sense version, XC6402FV / FX, only V_{DF(T)}>1.5V type are available.

■ ELECTRICAL CHARACTERISTICS (Continued)

● Dropout Voltage, Supply Current, EN'H/L' Level Current

XC6402C Series

SETTING OUTPUT VOLTAGE (V)	VR OUTPUT VOLTAGE VD DETECT VOLTAGE (V)	E-1		E-2		E-3		E-4	E-5
		DROPOUT VOLTAGE 1 (mV)	DROPOUT VOLTAGE 2 (mV)	SUPPLY CURRENT (μ A)	EN'H'LEVEL CURRENT (μ A)	EN'H'LEVEL CURRENT (μ A)			
VROUT(T)	VOUT	Vdif1	Vdif2	IDD	IENH	IENL			
0.80	0.770	0.830							
0.85	0.820	0.880							
0.90	0.870	0.930							
0.95	0.920	0.980							
1.00	0.970	1.030							
1.05	1.020	1.080							
1.10	1.070	1.130							
1.15	1.120	1.180							
1.20	1.170	1.230							
1.25	1.220	1.280							
1.30	1.270	1.330							
1.35	1.320	1.380							
1.40	1.370	1.430							
1.45	1.420	1.480							
1.50	1.470	1.530							
1.55	1.519	1.581							
1.60	1.568	1.632							
1.65	1.617	1.683							
1.70	1.666	1.734							
1.75	1.715	1.785							
1.80	1.764	1.836							
1.85	1.813	1.887							
1.90	1.862	1.938							
1.95	1.911	1.989							
2.00	1.960	2.040							
2.05	2.009	2.091							
2.10	2.058	2.142							
2.15	2.107	2.193							
2.20	2.156	2.244							
2.25	2.205	2.295							
2.30	2.254	2.346							
2.35	2.303	2.397							
2.40	2.352	2.448							
2.45	2.401	2.499							
2.50	2.450	2.550							
2.55	2.499	2.601							
2.60	2.548	2.652							
2.65	2.597	2.703							
2.70	2.646	2.754							
2.75	2.695	2.805							
2.80	2.744	2.856							
2.85	2.793	2.907							
2.90	2.842	2.958							
2.95	2.891	3.009							

■ELECTRICAL CHARACTERISTICS (Continued)

●Dropout Voltage, Supply Current, EN'H/L' Level Current (Continued)

XC6402C Series (Continued)

SETTING OUTPUT VOLTAGE (V)	VR OUTPUT VOLTAGE VD DETECT VOLTAGE (V)	E-1		E-2		E-3		E-4	E-5
		DROPOUT VOLTAGE 1 (mV)	DROPOUT VOLTAGE 2 (mV)	SUPPLY CURRENT (μ A)		EN'H'LEVEL CURRENT (μ A)	EN'H'LEVEL CURRENT (μ A)		
	VOUT	Vdif1	Vdif2	IDD		IENH	IENL		
VROUT(T)	MIN.	MAX.	TYP.	MAX.	TYP.	MAX.	TYP.	MAX.	TYP.
3.00	2.940	3.060							
3.05	2.989	3.111							
3.10	3.038	3.162							
3.15	3.087	3.213							
3.20	3.136	3.264							
3.25	3.185	3.315							
3.30	3.234	3.366							
3.35	3.283	3.417							
3.40	3.332	3.468							
3.45	3.381	3.519							
3.50	3.430	3.570							
3.55	3.479	3.621							
3.60	3.528	3.672							
3.65	3.577	3.723							
3.70	3.626	3.774							
3.75	3.675	3.825							
3.80	3.724	3.876							
3.85	3.773	3.927							
3.90	3.882	3.978							
3.95	3.871	4.029							
4.00	3.920	4.080	15.0						
4.05	3.969	4.131	23.0						
4.10	4.018	4.182	50.0						
4.15	4.067	4.233	75.0						
4.20	4.116	4.284							
4.25	4.165	4.335							
4.30	4.214	4.386							
4.35	4.263	4.437							
4.40	4.312	4.488							
4.45	4.361	4.539							
4.50	4.410	4.590							
4.55	4.459	4.641							
4.60	4.508	4.692							
4.65	4.557	4.743							
4.70	4.606	4.794							
4.75	4.655	4.845							
4.80	4.704	4.896							
4.85	4.753	4.947							
4.90	4.802	4.998							
4.95	4.851	5.049							
5.00	4.900	5.100							

■ ELECTRICAL CHARACTERISTICS (Continued)

● Dropout Voltage

XC6402F Series

SETTING OUTPUT VOLTAGE (V)	VR OUTPUT VOLTAGE VD DETECT VOLTAGE (V)	E-1		E-2	
		DROPOUT VOLTAGE 1 (mV)		DROPOUT VOLTAGE 2 (mV)	
		VOUT	Vdif1	Vdif2	
VROUT(T)	MIN.	MAX.	TYP.	MAX.	TYP.
0.80	0.770	0.830	100	700	250
0.85	0.820	0.880		600	
0.90	0.870	0.930			700
0.95	0.920	0.980			
1.00	0.970	1.030	50	500	150
1.05	1.020	1.080		400	
1.10	1.070	1.130			500
1.15	1.120	1.180			
1.20	1.170	1.230	30	300	100
1.25	1.220	1.280		200	
1.30	1.270	1.330		100	
1.35	1.320	1.380			250
1.40	1.370	1.430	27.0	41.0	90.0
1.45	1.420	1.480			
1.50	1.470	1.530			
1.55	1.519	1.581			
1.60	1.568	1.632			
1.65	1.617	1.683			
1.70	1.666	1.734			
1.75	1.715	1.785			
1.80	1.764	1.836			
1.85	1.813	1.887			
1.90	1.862	1.938			
1.95	1.911	1.989			
2.00	1.960	2.040			
2.05	2.009	2.091			
2.10	2.058	2.142			
2.15	2.107	2.193	25.0	37.0	80.0
2.20	2.156	2.244			
2.25	2.205	2.295			
2.30	2.254	2.346			
2.35	2.303	2.397			
2.40	2.352	2.448			
2.45	2.401	2.499			
2.50	2.450	2.550			
2.55	2.499	2.601			
2.60	2.548	2.652			
2.65	2.597	2.703	18.0	28.0	60.0
2.70	2.646	2.754			
2.75	2.695	2.805			
2.80	2.744	2.856			
2.85	2.793	2.907			
2.90	2.842	2.958			
2.95	2.891	3.009			

■ELECTRICAL CHARACTERISTICS (Continued)

●Dropout Voltage (Continued)

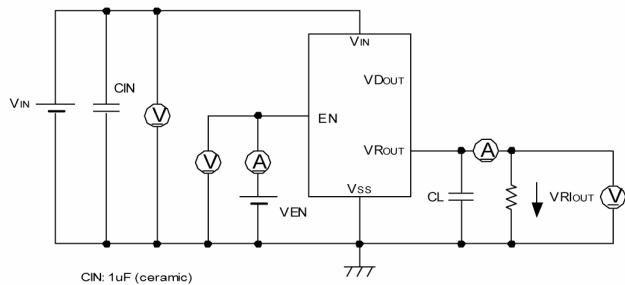
XC6402F Series (Continued)

SETTING OUTPUT VOLTAGE (V)	VR OUTPUT VOLTAGE VD DETECT VOLTAGE (V)	E-1		E-2	
		DROPOUT VOLTAGE 1 (mV)		DROPOUT VOLTAGE 2 (mV)	
		VOUT	Vdif1	Vdif2	
3.00	2.940	3.060			
3.05	2.989	3.111			
3.10	3.038	3.162			
3.15	3.087	3.213			
3.20	3.136	3.264			
3.25	3.185	3.315			
3.30	3.234	3.366			
3.35	3.283	3.417			
3.40	3.332	3.468			
3.45	3.381	3.159			
3.50	3.430	3.570			
3.55	3.479	3.621			
3.60	3.528	3.672			
3.65	3.577	3.723			
3.70	3.626	3.774			
3.75	3.675	3.825			
3.80	3.724	3.876			
3.85	3.773	3.927			
3.90	3.882	3.978			
3.95	3.871	4.029			
4.00	3.920	4.080			
4.05	3.969	4.131			
4.10	4.018	4.182			
4.15	4.067	4.233			
4.20	4.116	4.284			
4.25	4.165	4.335			
4.30	4.214	4.386			
4.35	4.263	4.437			
4.40	4.312	4.488			
4.45	4.361	4.539			
4.50	4.410	4.590			
4.55	4.459	4.641			
4.60	4.508	4.692			
4.65	4.557	4.743			
4.70	4.606	4.794			
4.75	4.655	4.845			
4.80	4.704	4.896			
4.85	4.753	4.947			
4.90	4.802	4.998			
4.95	4.851	5.049			
5.00	4.900	5.100			

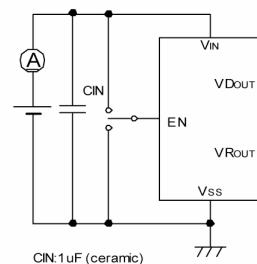
■ TEST CIRCUITS

XC6402C Series

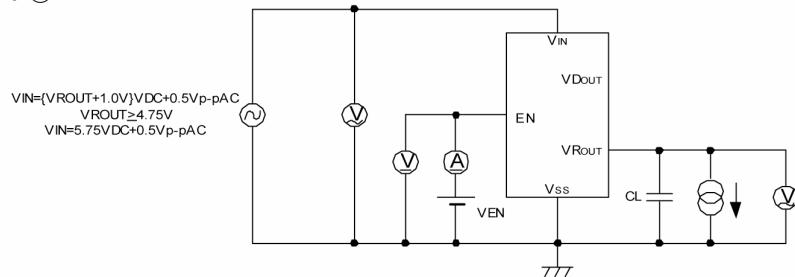
Circuit ①



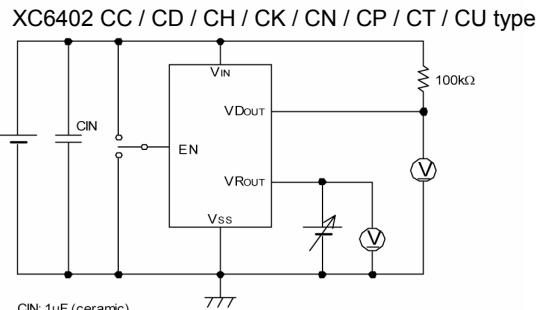
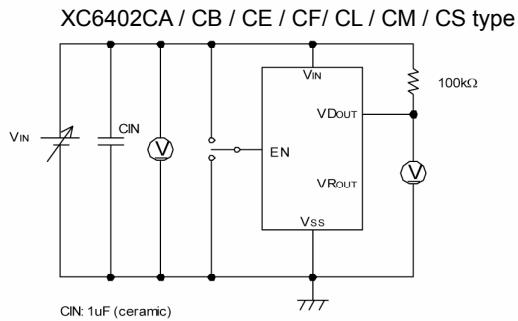
Circuit ②



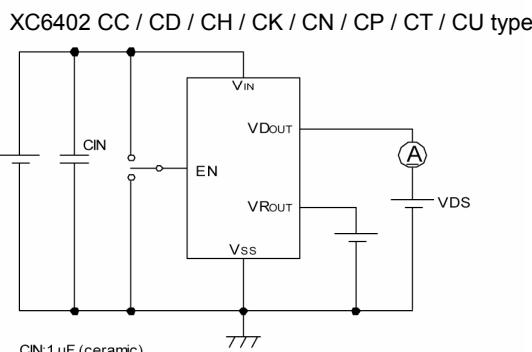
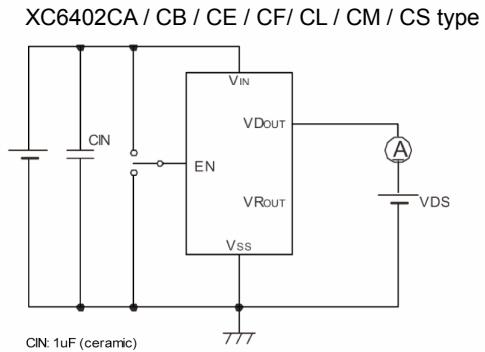
Circuit ③



Circuit ④



Circuit ⑤



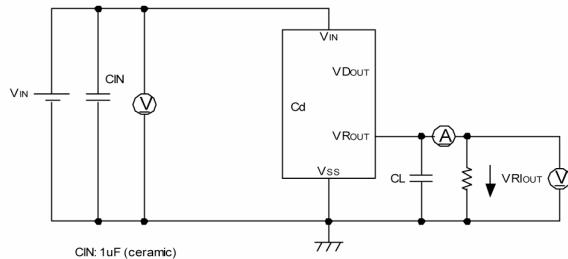
Output Capacitor Corresponding Chart

VR OUTPUT VOLTAGE	0.8 ~ 1.45V	1.5 ~ 1.75V	1.8V ~ 5.0V
CL	$6.8 \mu F$	$2.2 \mu F$	$1.0 \mu F$

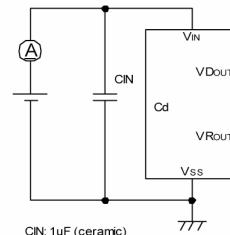
■ TEST CIRCUITS (Continued)

XC6402F Series

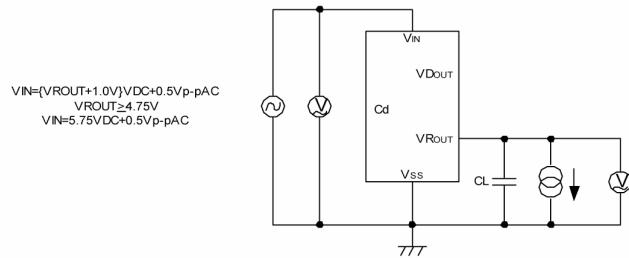
Circuit ①



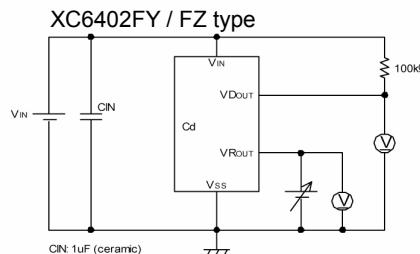
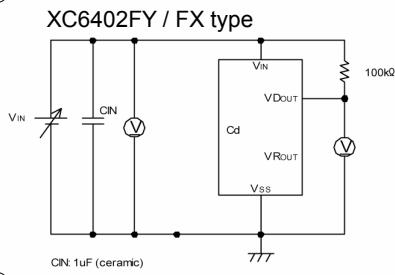
Circuit ②



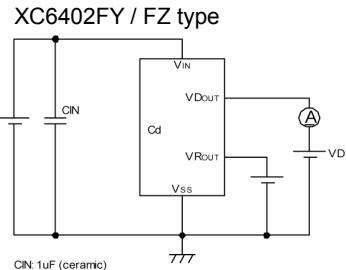
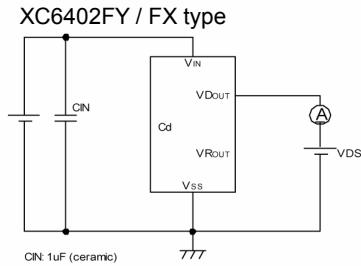
Circuit ③



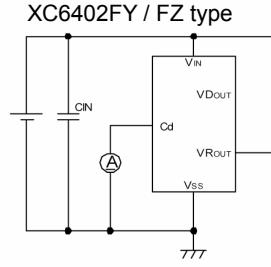
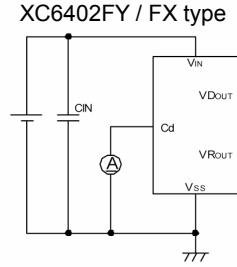
Circuit ④



Circuit ⑤



Circuit ⑥



Output Capacitor Corresponding Chart

VR OUTPUT VOLTAGE	0.8 ~ 1.45V	1.5 ~ 1.75V	1.8V ~ 5.0V
CL	$6.8\mu F$	$2.2\mu F$	$1.0\mu F$

■ OPERATIONAL EXPLANATION

<Output Voltage Regulator Control>

The voltage, divided by resistors R1 & R2 which are connected to the VR_{OUT} pin is compared with the internal reference voltage by the error amplifier. The P-channel MOSFET, which is connected to the VR_{OUT} pin, is then driven by the subsequent output signal. The output voltage at the VR_{OUT} pin is controlled & stabilized by negative feedback. The current limit circuit and short circuit protection operate in relation to the level of output current. Further, the voltage regulator's internal circuitry can be shutdown via the EN pin's signal.

<Detector Function with the XC6402 Series>

The series' detector function monitors the voltage divided by resistors R3 & R4 which are connected to the VR_{OUT} pin or the V_{IN} pin, as well as monitoring the voltage of the internal reference voltage source via the comparator.

The V_{DSEN} pin has options (please refer to the Selection Guide, item 2).

A 'High' or 'Low' signal level can be output from the V_{DOUT} pin when the V_D pin voltage level goes below the detect voltage. The V_D output logic has options (please refer to the Selection Guide, item 3). As V_{DOUT} is an open-drain N-channel output, a pull-up resistor of about 220kΩ is needed to achieve a voltage output. Because of hysteresis at the detector function, output at the V_{DOUT} pin will invert when the detect voltage level increases above the release voltage (105% of the detect voltage).

For the XC6402C type, in stand-by, if a voltage of the recovery voltage is present at the VR_{OUT} pin (from another power source), the V_{DOUT} pin will be high impedance mode, and the pull up voltage will be output at V_{DOUT}. By connecting the Cdelay pin to a capacitor (Cd), the XC6402F series can apply a delay time to V_{DOUT} voltage when releasing voltage. The delay time can be calculated from the internal resistance, Rdelay (2MΩ TYP. fixed) and the value of Cd as per the following equation.

$$\text{Delay Time} = \text{Cdelay} \times \text{Rdelay} \times 0.7$$

Delay Time	Rdelay standard : 1.0 ~ 3.5MΩ	TYP : 2.0MΩ
Cdelay	DELAY TIME (TYP.)	DELAY TIME (TYP.)
0.01 μ F	14 msec	7.0 ~ 24.5 msec
0.022 μ F	30.8 msec	15.4 ~ 53.9 msec
0.047 μ F	65.8 msec	32.9 ~ 115.15 msec
0.1 μ F	140 msec	70.0 ~ 245.0 msec
0.22 μ F	308 msec	154.0 ~ 539.0 msec
0.47 μ F	658 msec	329.0 ~ 1151.5 msec
1 μ F	1400 msec	700.0 ~ 2450.0 msec

<Low ESR Capacitors>

With the XC6402 series regulator, a stable output voltage is achievable even if low ESR capacitors are used, as a phase compensation circuit is built-in to the regulator. In order to ensure the effectiveness of the phase compensation, we suggest that an output capacitor (CL) be connected as close as possible, between the output pin (VR_{OUT}) and the V_{SS} pin. Please use an output capacitor (CL) with a capacitance, based on the chart below. We also suggest an input capacitor (C_{IN}) of 1μF : this should be connected between V_{IN} and V_{SS} in order to stabilize input power source.

Output Capacitor Corresponding Chart

VR OUTPUT VOLTAGE	0.8 ~ 1.45V	1.5 ~ 1.75V	1.8V ~ 5.0V
CL	6.8 μ F	2.2 μ F	1.0 μ F

<Current Limiter, Short-Circuit Protection>

The XC6402 series regulator offers a combination of current limit and circuit protection by means of a built-in fixed current limiter circuit and a foldback circuit. When the load current reaches the current limit level, the fixed current limiter circuit operates and output voltage drops. As a result of this drop in output voltage, the foldback circuit operates, the output voltage drops further and output current decreases. When the output pin is shorted, a current of about 30mA flows.

■OPERATIONAL EXPLANATION (Continued)

<EN Pin>

The IC's internal regulator circuitry can be shut down via the signal from the EN pin with the XC6402C series. In shutdown mode, output at the VROUT pin will be pulled down to the Vss level via R1 & R2. Note that as the XC6402*E to K types of the XC6402C series are 'High Active / No Pull-Down' and XC6402*R to U types of the XC6402C series are 'Active LOW / No Pull-Up', operations will become unstable with the EN pin open (See the chart below).

SERIES	EN INPUT LOGIC
XC6402C A ~ D	High Active with pull-down resistor
XC6402C E ~ K	High Active with no pull-down resistor
XC6402C L ~ P	Low Active with pull-up resistor
XC6402C R ~ U	Low Active with no pull-up resistor

We suggest that you use this IC with either a VIN voltage or a Vss voltage input at the EN pin. If this IC is used with the correct specifications for the EN pin, the IC will operate normally. However, supply current may increase as a result of through current in the IC's internal circuitry if a voltage other than VIN or Vss is applied.

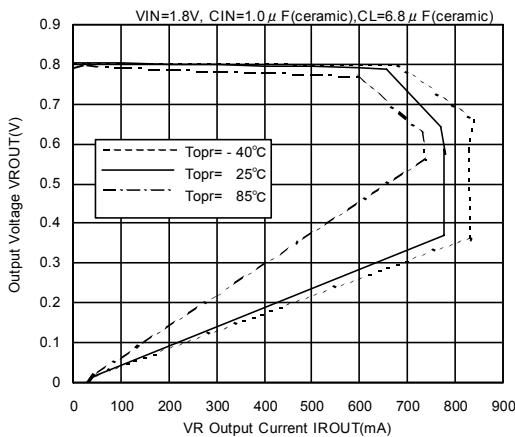
■NOTES ON USE

1. Please use this IC within the stated absolute maximum ratings. The IC is liable to malfunction should the ratings be exceeded.
2. Where wiring impedance is high, operations may become unstable due to noise and/or phase lag depending on output current. Please strengthen VIN and Vss wiring in particular.
3. Please wire the input capacitor (CIN) and the output capacitor (CL) as close to the IC as possible.
Should rapid input fluctuation or load fluctuation occur, please increase the capacitor value such as CIN or CL to stabilize the operation.

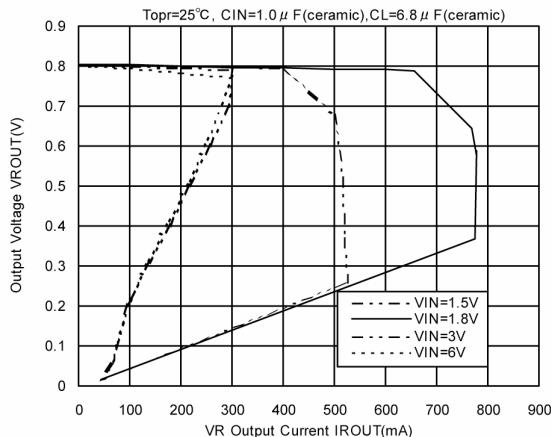
■ TYPICAL PERFORMANCE CHARACTERISTICS

(1) VR Output Voltage vs. VR Output Current

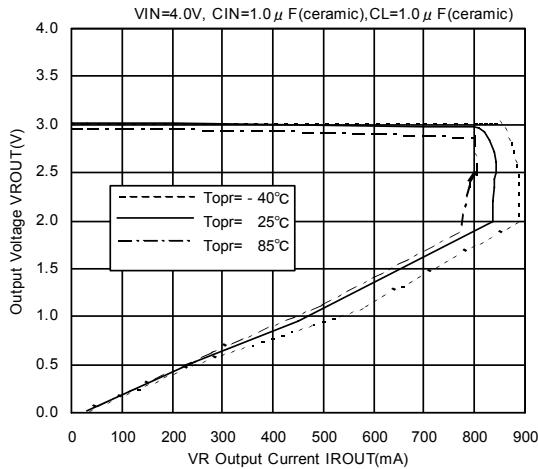
XC6402 Series (VR: 0.8V)



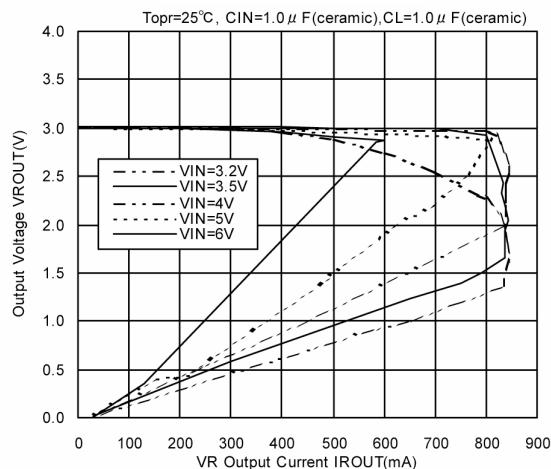
XC6402 Series (VR: 0.8V)



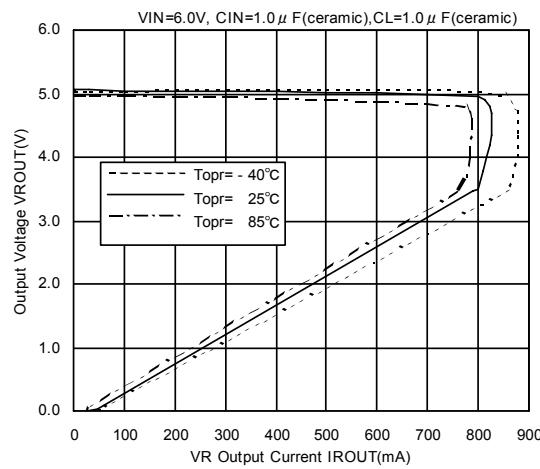
XC6402 Series (VR: 3.0V)



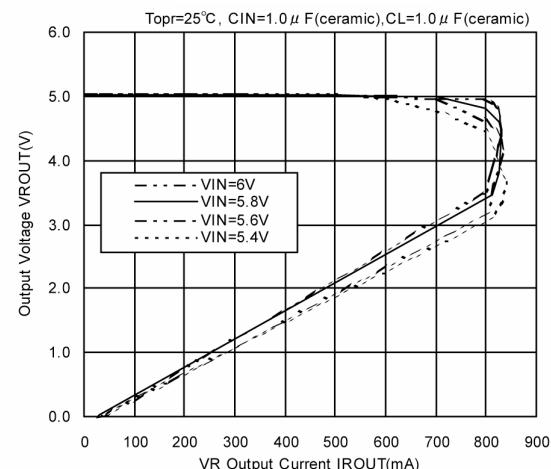
XC6402 Series (VR: 3.0V)



XC6402 Series (VR: 5.0V)

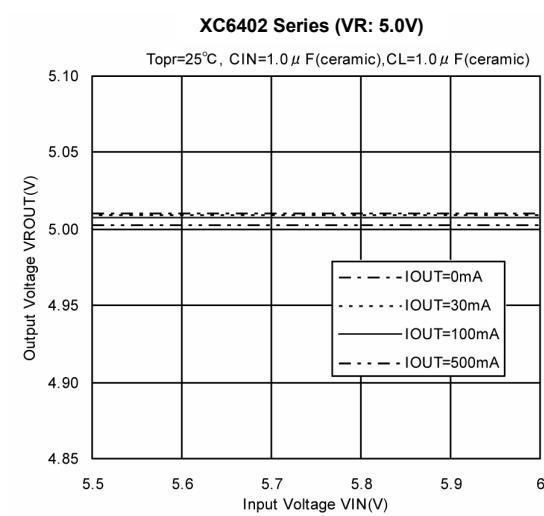
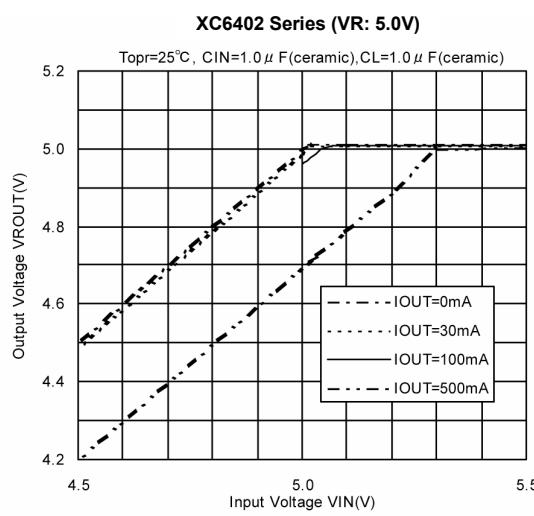
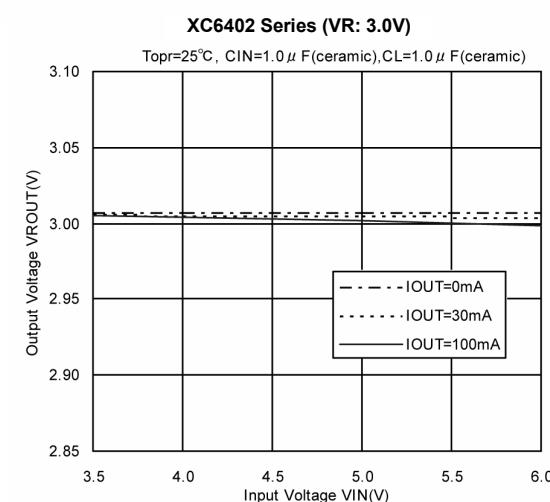
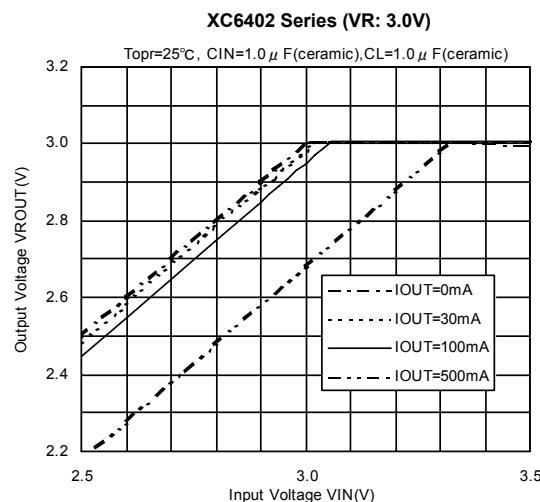
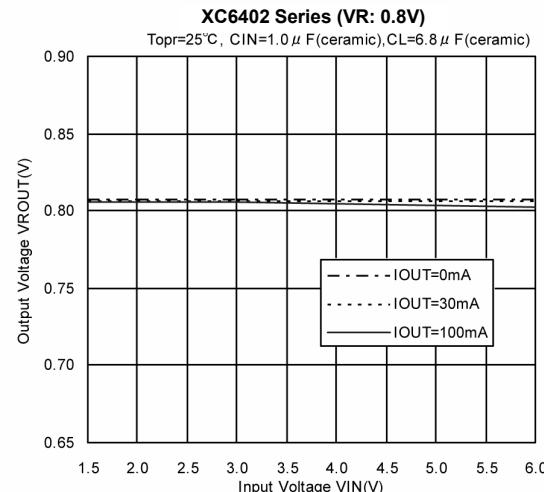
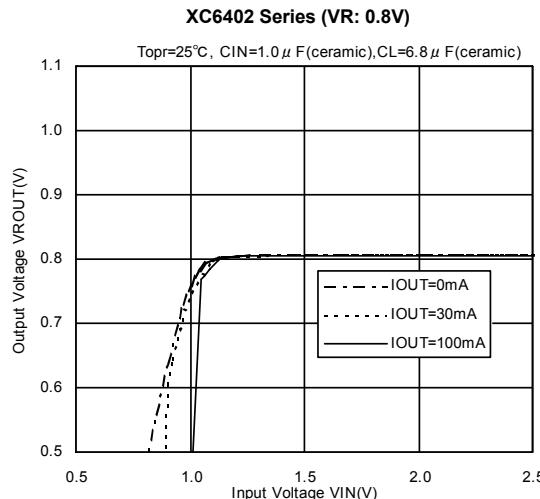


XC6402 Series (VR: 5.0V)



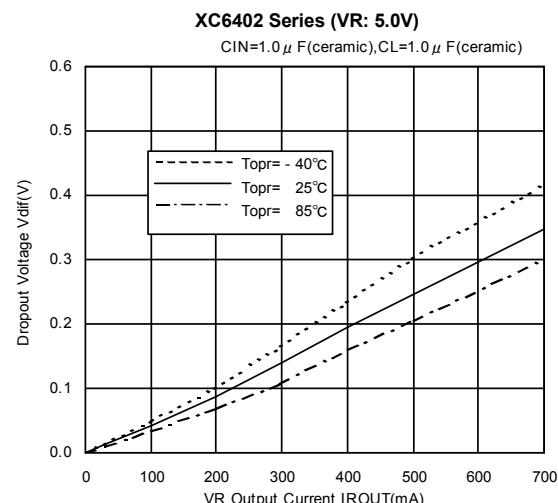
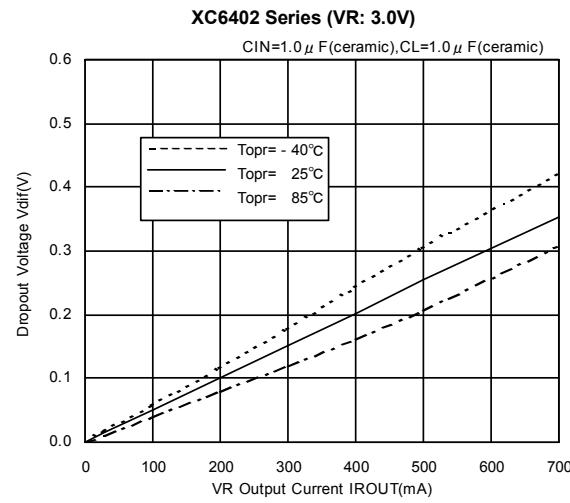
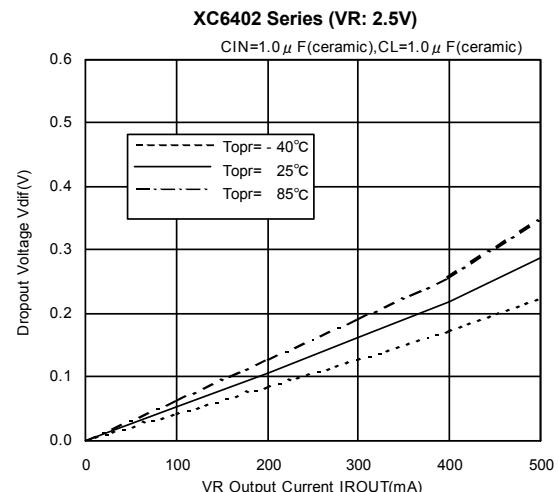
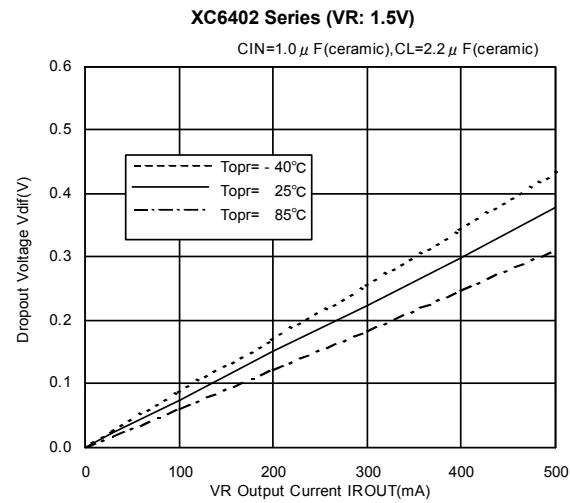
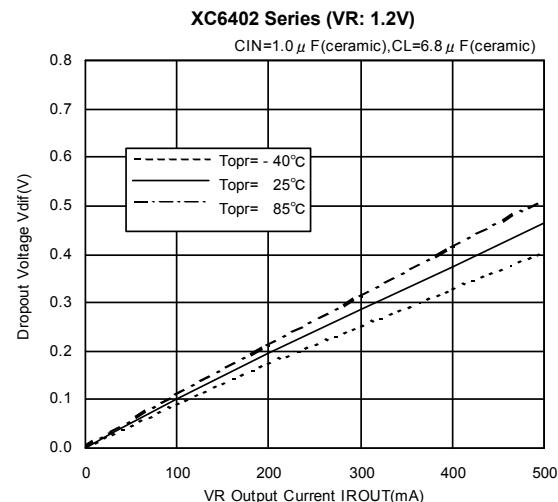
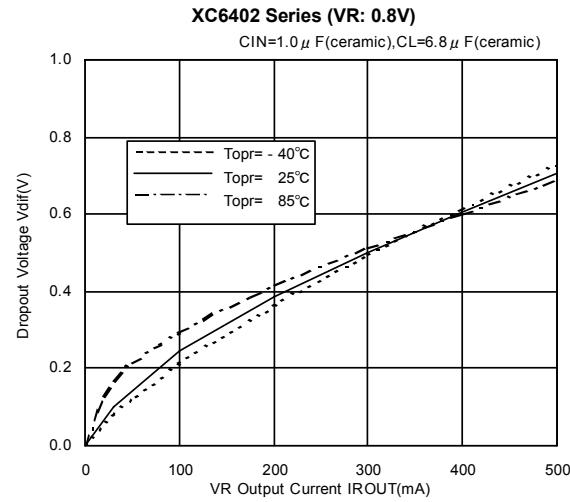
■ TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(2) VR Output Voltage vs. Input Voltage



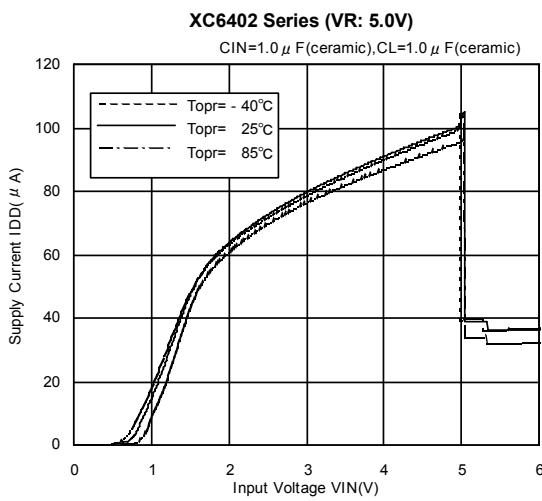
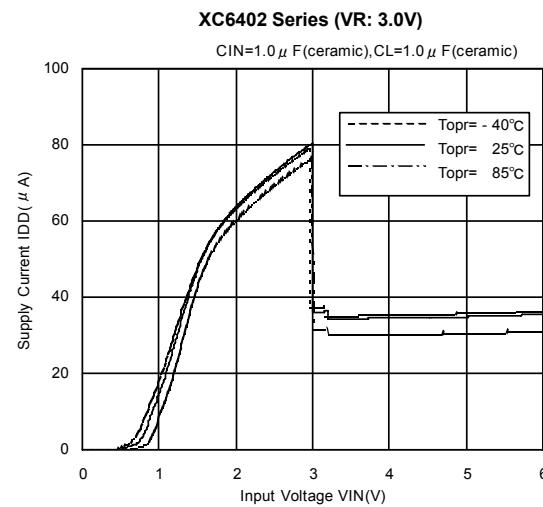
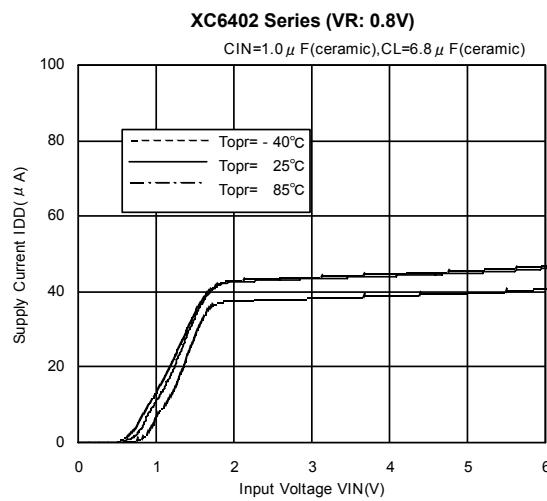
■ TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(3) Dropout Voltage vs. Output Current

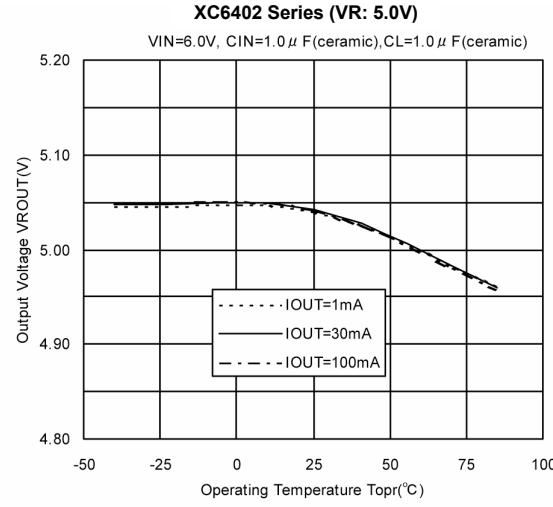
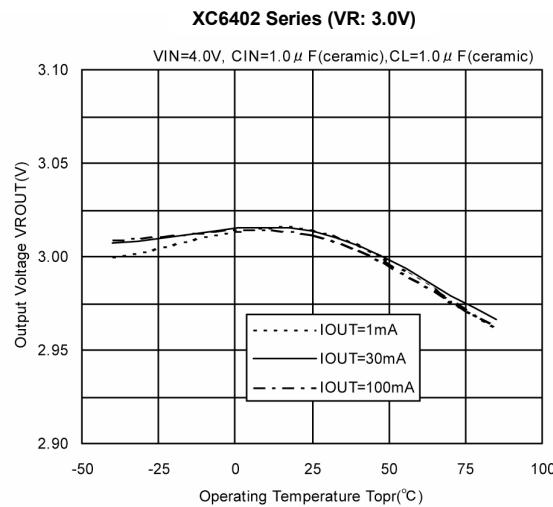
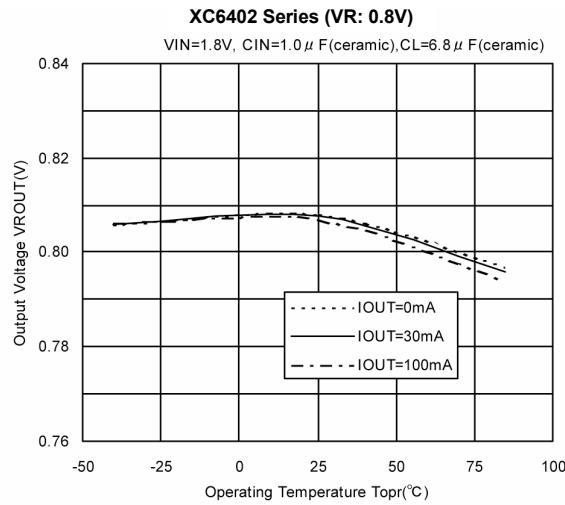


■ TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(4) Supply Current vs. Input Voltage

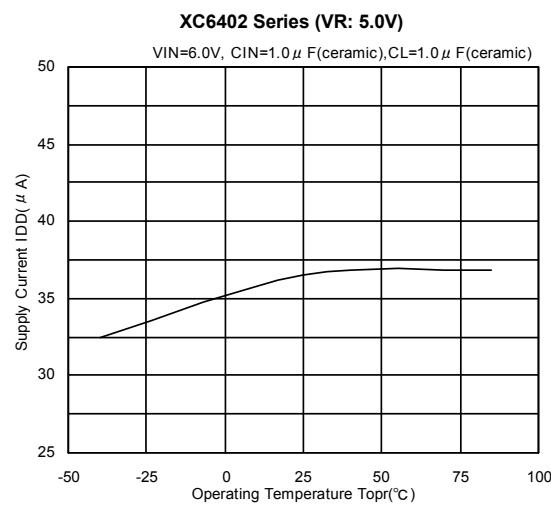
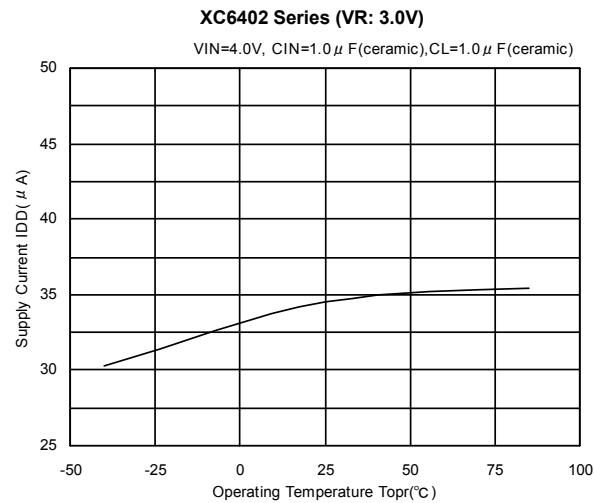
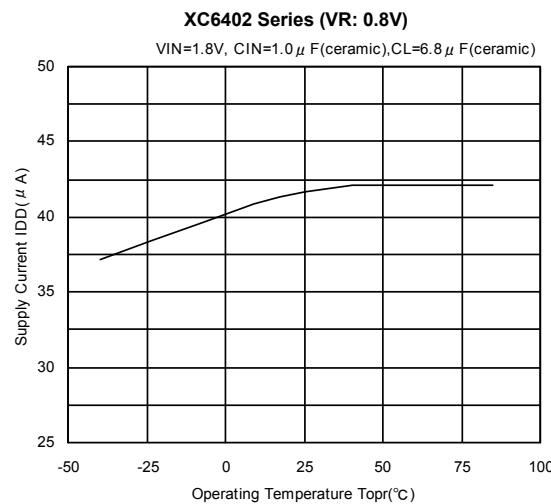


(5) VR Output Voltage vs. Operating Temperature

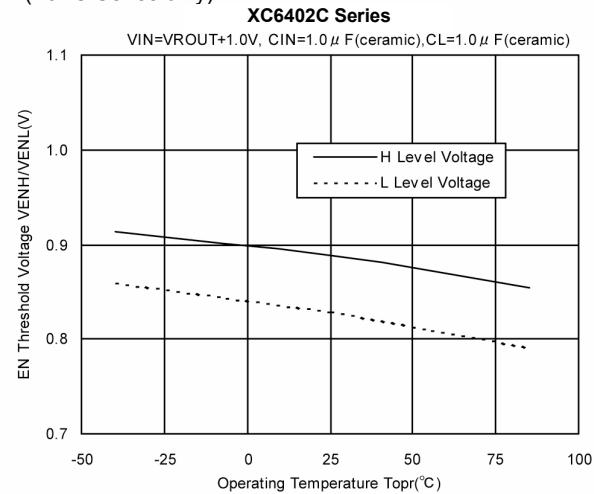


■ TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

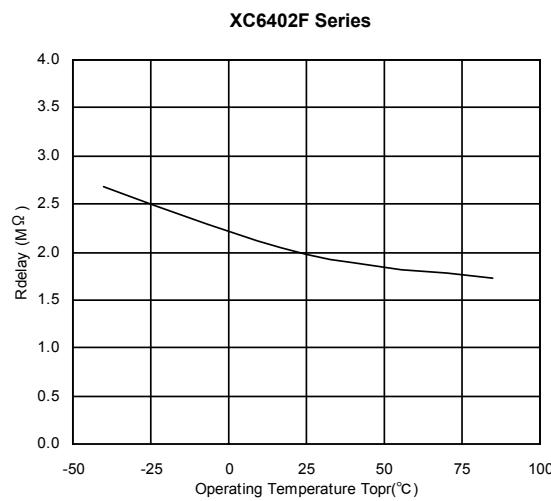
(6) Supply Current vs. Operating Temperature



(7) EN Threshold Voltage vs. Operating Temperature
(For C Series only)

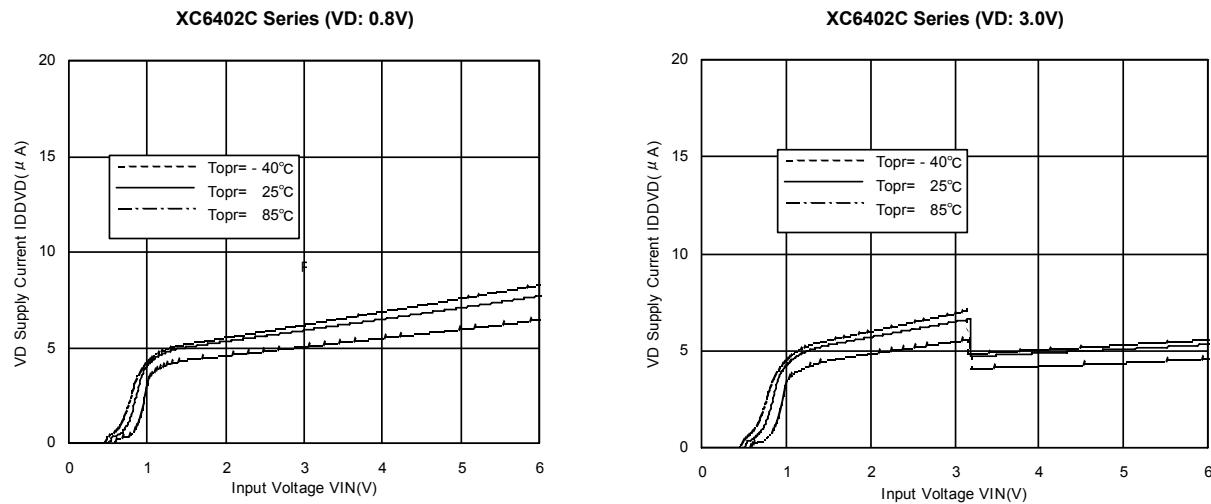


(8) Rdelay vs. Operating Temperature (For F Series only)

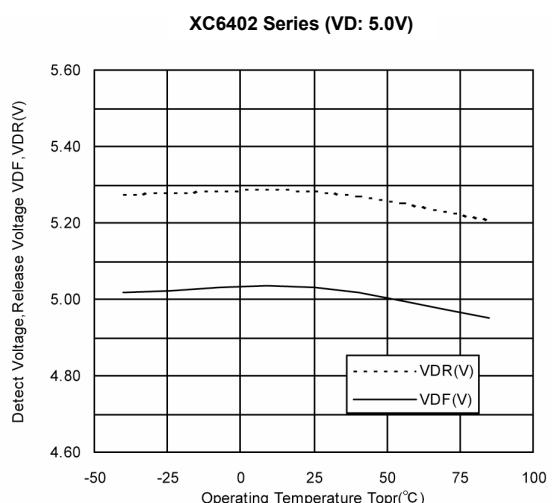
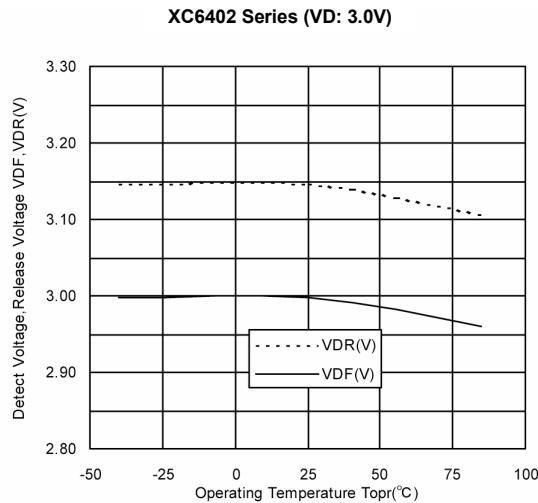
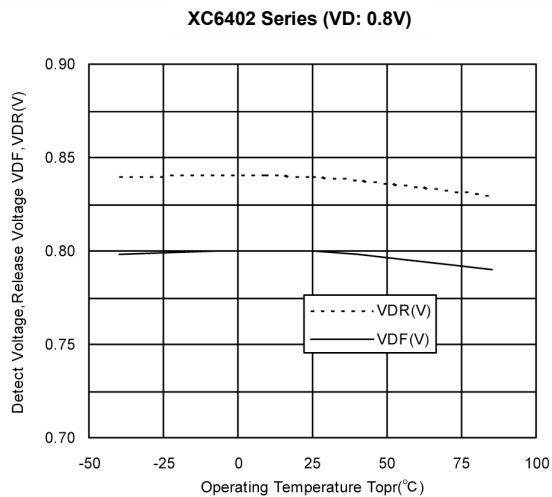


■ TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(9) VD Supply Current vs. Input Voltage (For C Series only)

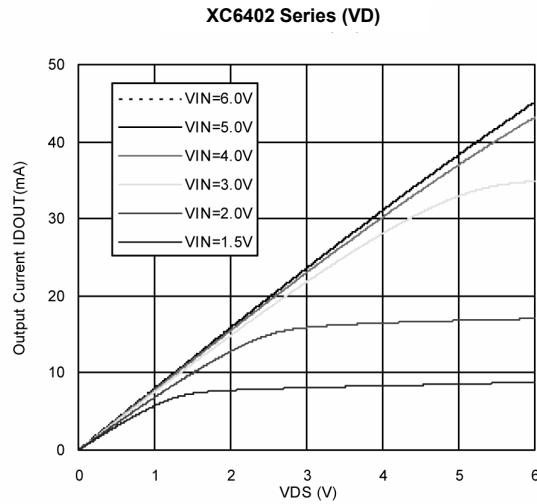


(10) Detect Voltage & Release Voltage vs. Operating Temperature

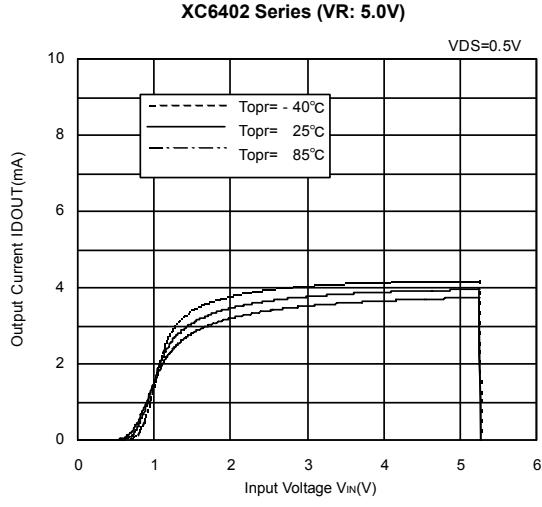
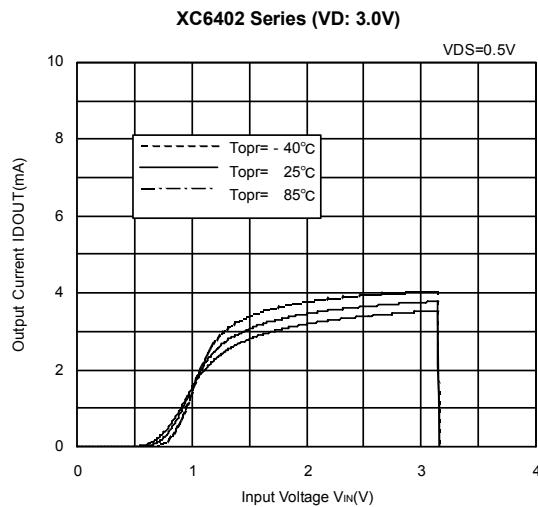
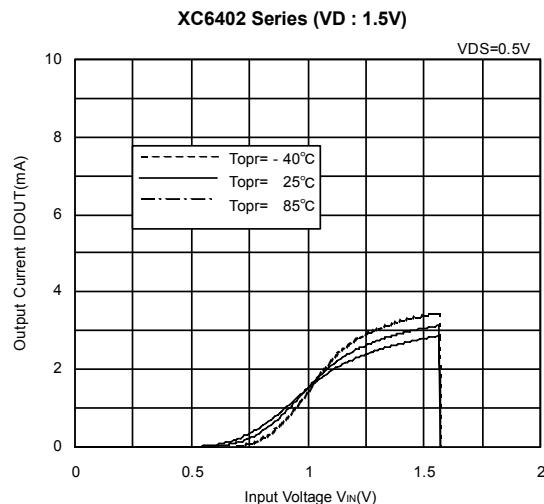


■ TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(11) VD N-ch Driver Tr. Output Current vs. V_{DS}

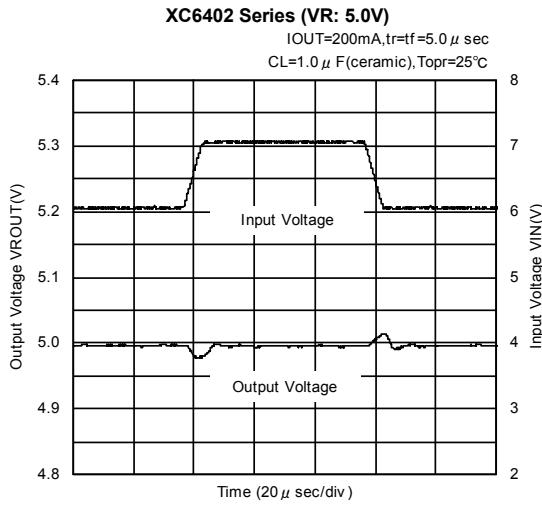
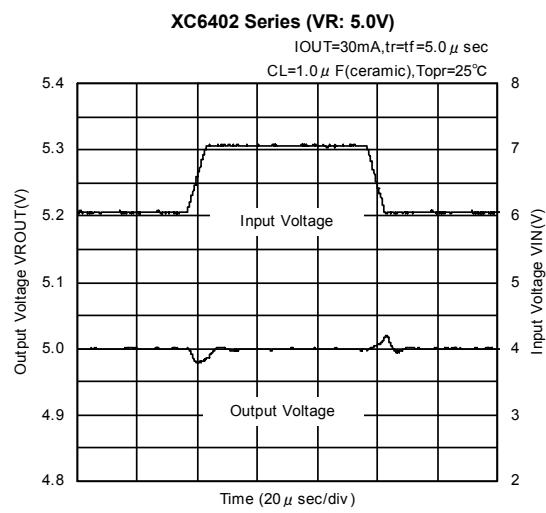
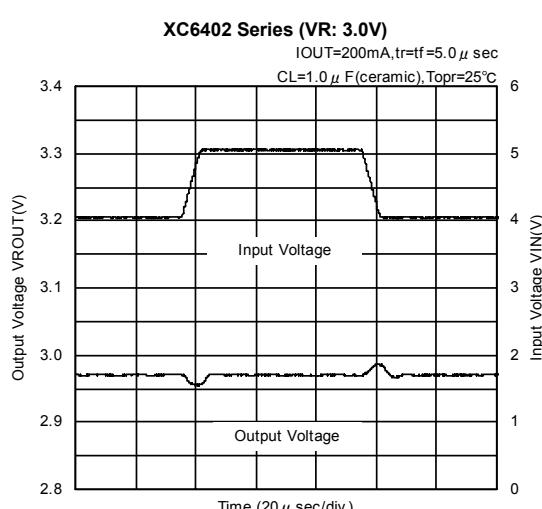
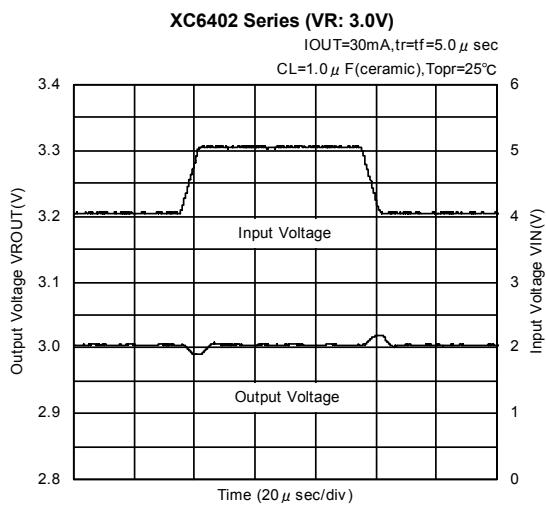
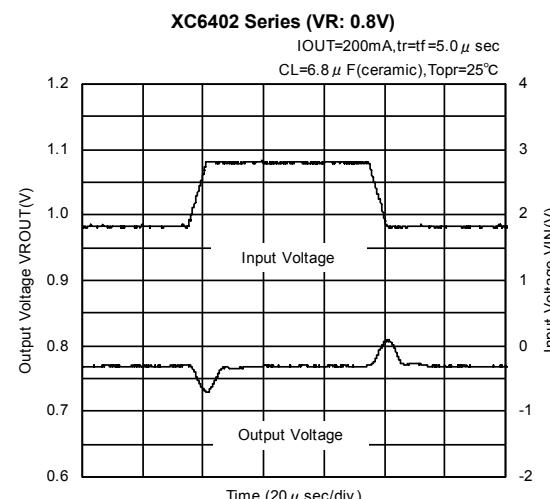
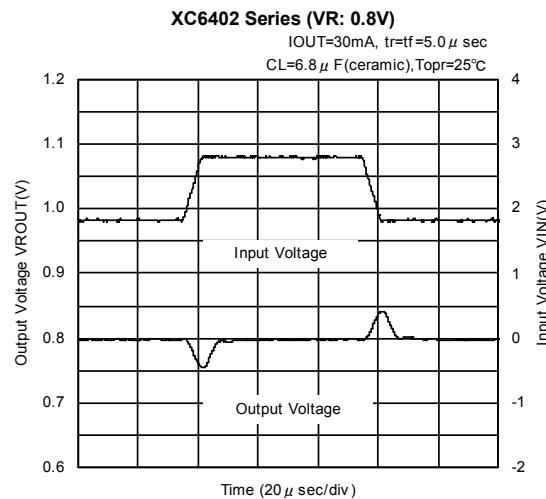


(12) VD N-ch Driver Tr. Output Current vs. Input Voltage



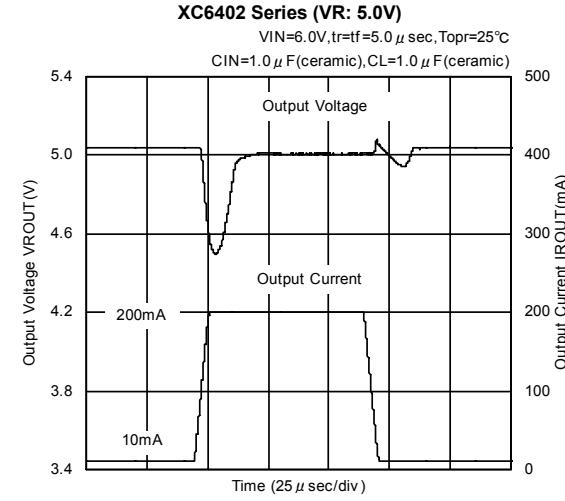
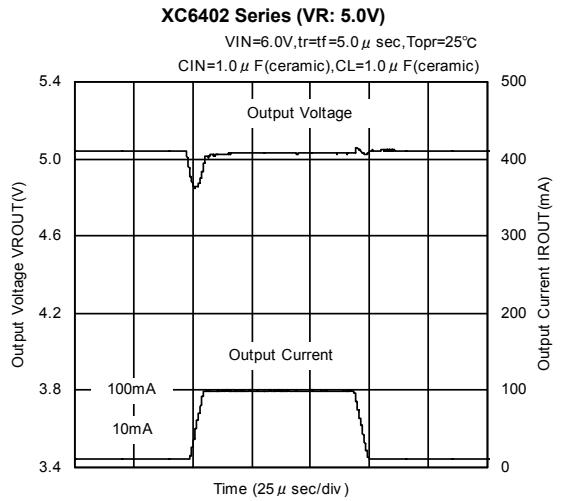
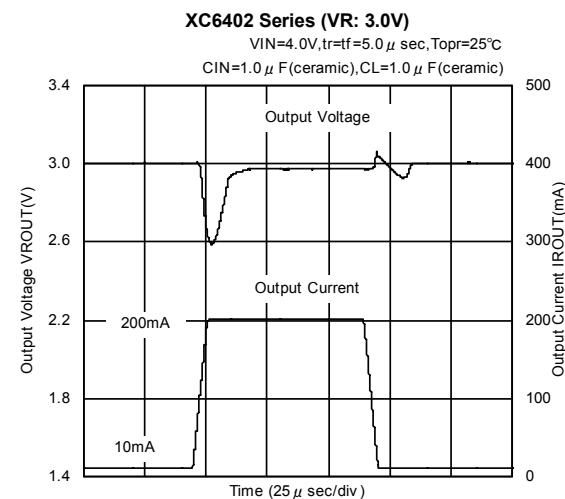
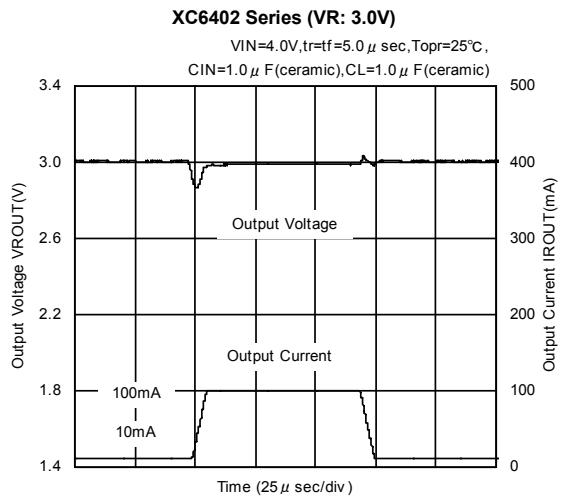
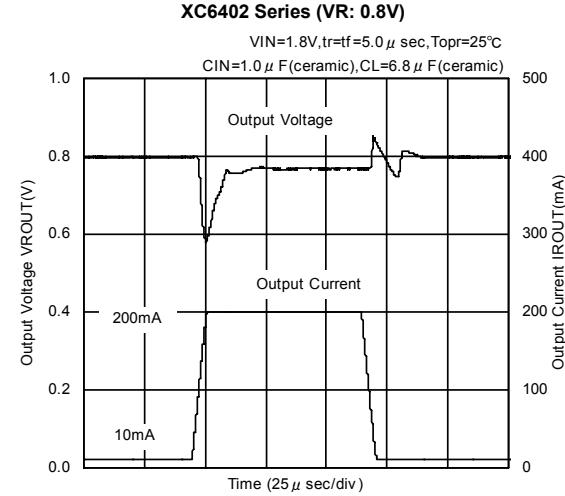
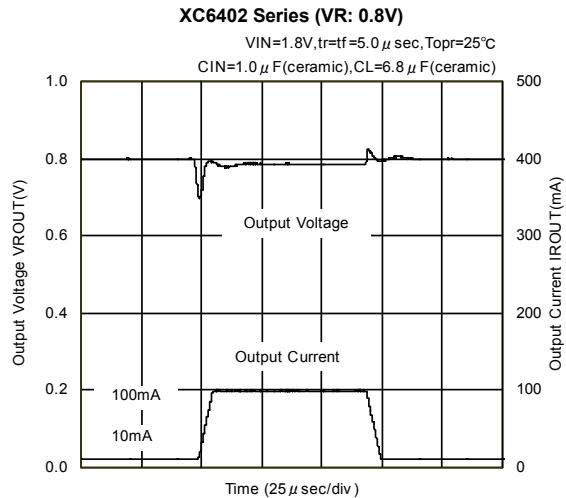
■ TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(13) VR Input Transient Response



■ TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(14) VR Load Transient Response

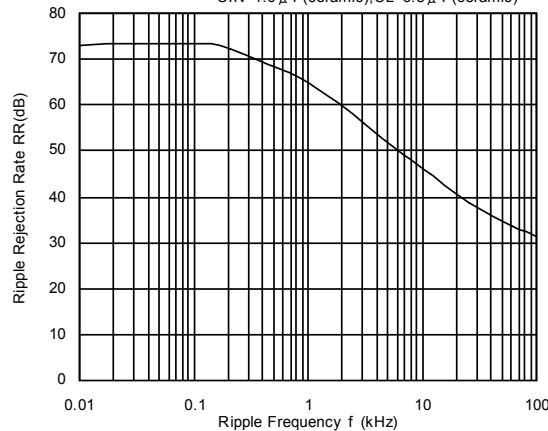


■ TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(15) Ripple Rejection Rate

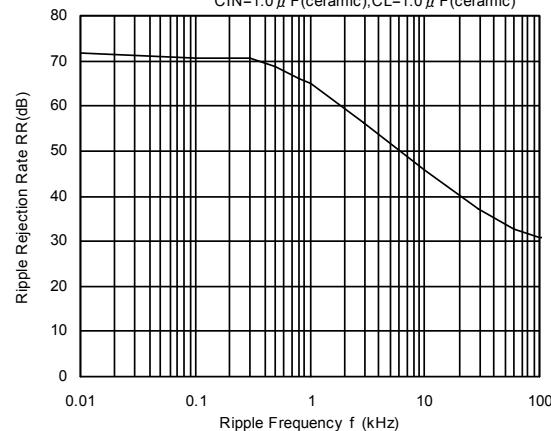
XC6402 Series (VR: 3.0V)

VIN=1.8VDC+0.5Vp-pAC,IOUT=30mA,Topr=25°C
CIN=1.0 μ F(ceramic),CL=6.8 μ F(ceramic)



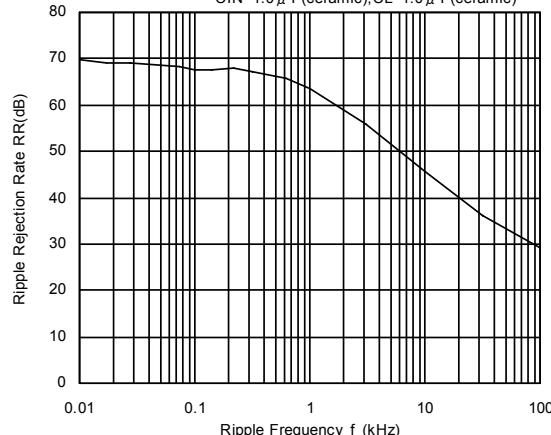
XC6402 Series (VR: 3.0V)

VIN=4.0VDC+0.5Vp-pAC,IOUT=30mA,Topr=25°C
CIN=1.0 μ F(ceramic),CL=1.0 μ F(ceramic)



XC6402 Series (VR: 3.0V)

VIN=5.75VDC+0.5Vp-pAC,IOUT=30mA,Topr=25°C,
CIN=1.0 μ F(ceramic),CL=1.0 μ F(ceramic)

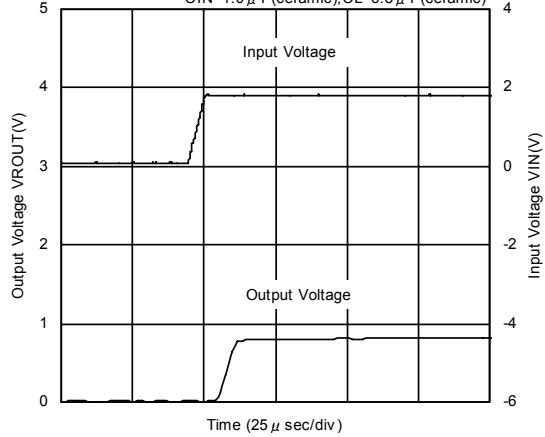


■ TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(16) Rising Response Time

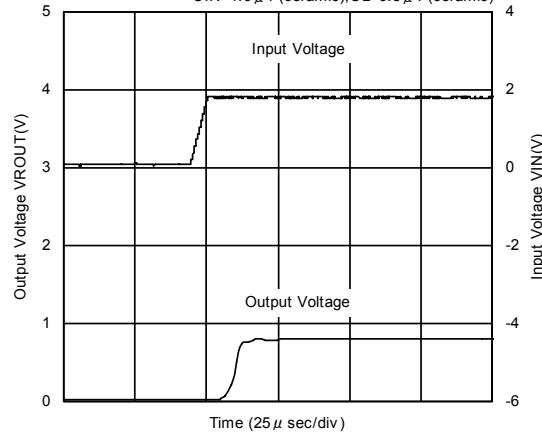
XC6402 Series (VR: 0.8V)

I_{OUT}=30mA, tr=5.0 μ sec, Topr=25°C
C_{IN}=1.0 μ F(ceramic), CL=6.8 μ F(ceramic)



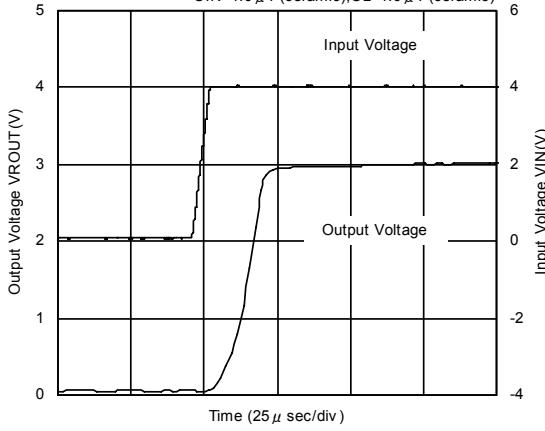
XC6402 Series (VR: 0.8V)

I_{OUT}=200mA, tr=5.0 μ sec, Topr=25°C
C_{IN}=1.0 μ F(ceramic), CL=6.8 μ F(ceramic)



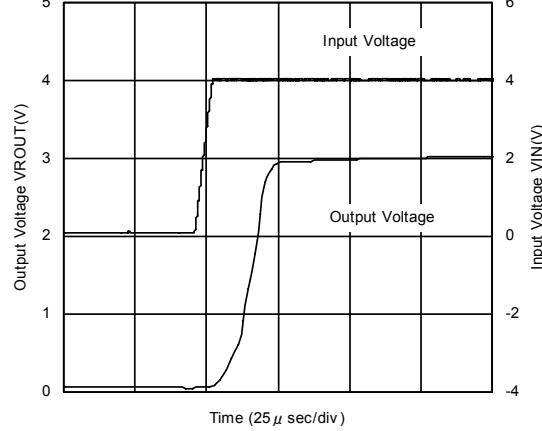
XC6402 Series (VR: 3.0V)

I_{OUT}=30mA, tr=5.0 μ sec, Topr=25°C
C_{IN}=1.0 μ F(ceramic), CL=1.0 μ F(ceramic)



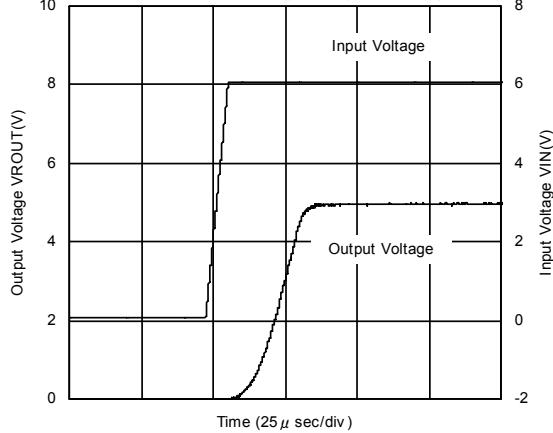
XC6402 Series (VR: 3.0V)

I_{OUT}=200mA, tr=5.0 μ sec, Topr=25°C
C_{IN}=1.0 μ F(ceramic), CL=1.0 μ F(ceramic)



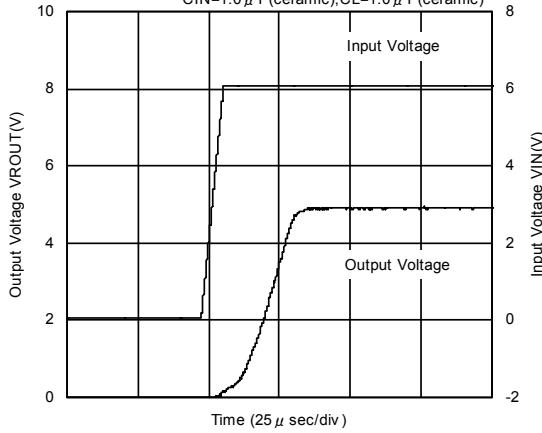
XC6402 Series (VR: 5.0V)

I_{OUT}=30mA, tr=5.0 μ sec, Topr=25°C
C_{IN}=1.0 μ F(ceramic), CL=1.0 μ F(ceramic)



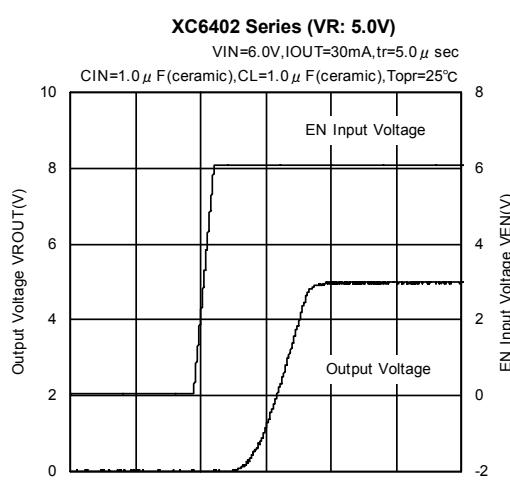
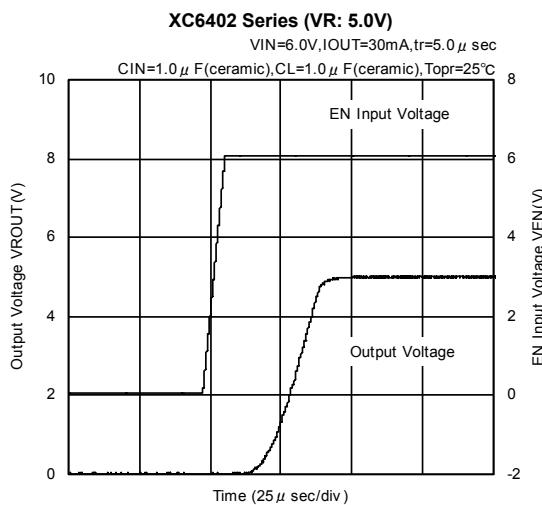
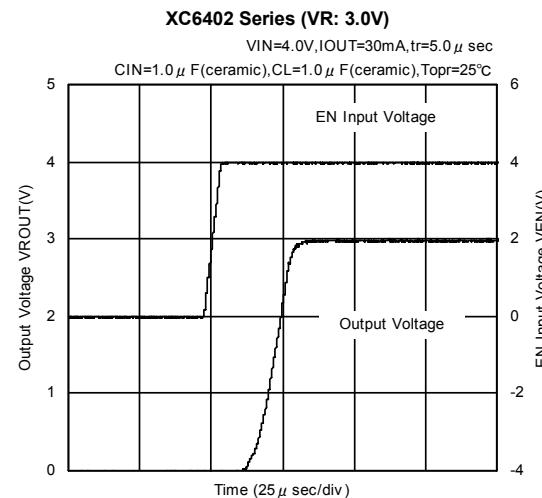
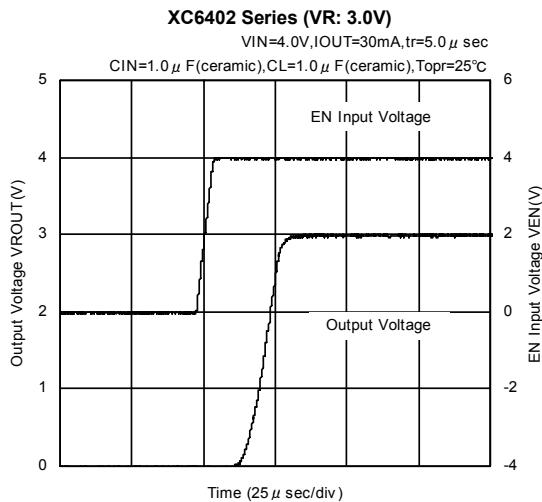
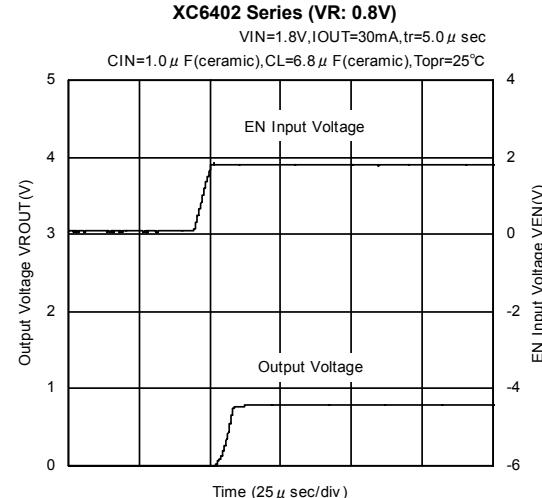
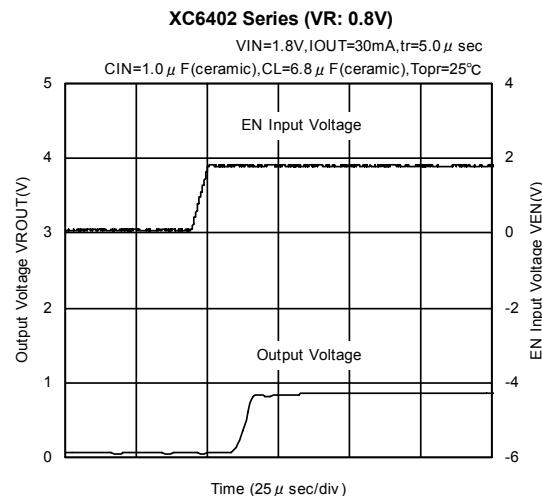
XC6402 Series (VR: 5.0V)

I_{OUT}=200mA, tr=5.0 μ sec, Topr=25°C
C_{IN}=1.0 μ F(ceramic), CL=1.0 μ F(ceramic)



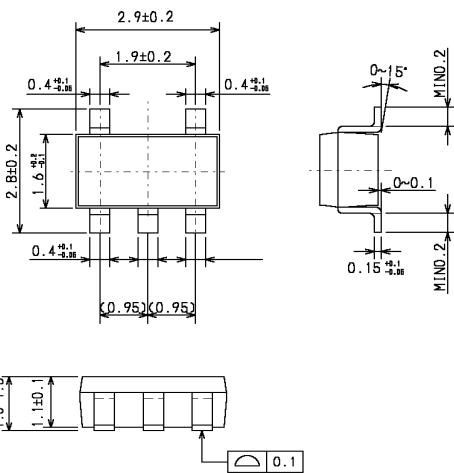
■ TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(17) EN Rising Response Time (For C Series only)

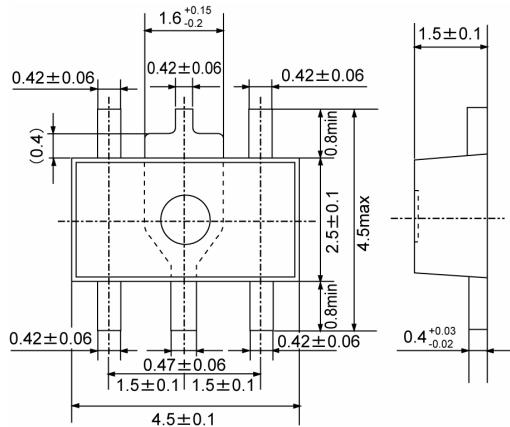


■ PACKAGING INFORMATION

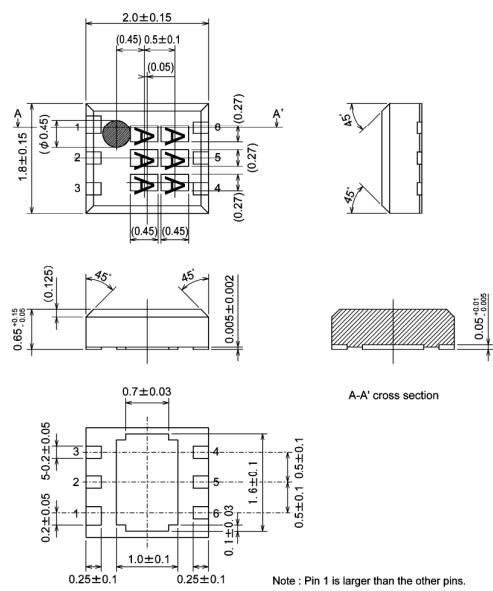
●SOT-25



●SOT-89-5

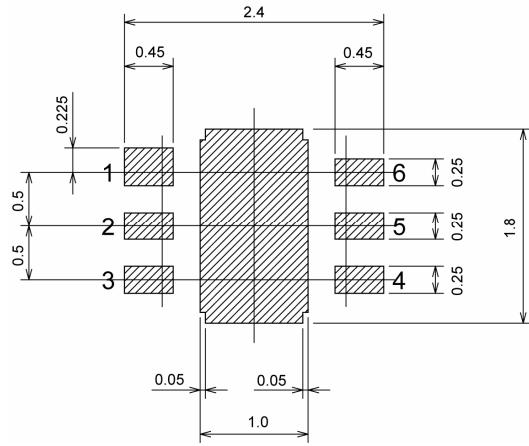


● USP-6B

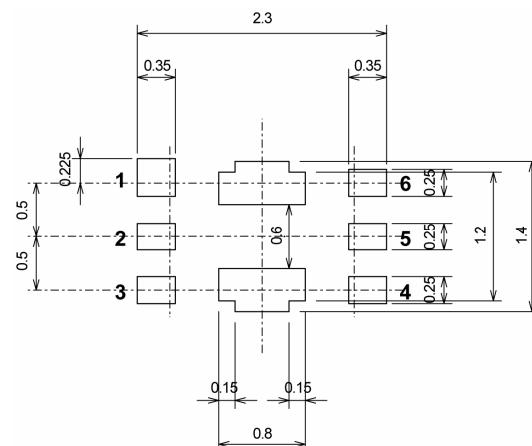


■PACKAGING INFORMATION (Continued)

●USP-6B Recommended Pattern Layout

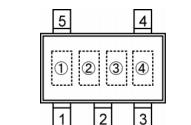


●USP-6B Recommended Metal Mask Design

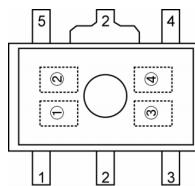


■ MARKING RULE

● SOT-25 / SOT-89-5



SOT-25
(TOP VIEW)



SOT-89-5
(TOP VIEW)

① Represents product series

MARK	PRODUCT SERIES
2	XC6402xxxxxx

②③ Represents internal sequential number

Sequential numbering rule

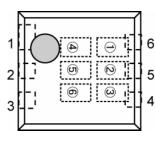
ORDER	NUMBERING RULE
1	01~09
2	10~99
3	A0~A9
4	B0~B9
5	~Z9

*G, I, J, O, Q, W excepted

④ Represents production lot number

0 to 9, A to Z repeated (G, I, J, O, Q, W excepted)

● USP-6B



USP-6B
(TOP VIEW)

① Represents product series

MARK	PRODUCT SERIES
5	XC6402xxxxDx

② Represents optional functions

MARK	PRODUCT SERIES
C	XC6402CxxxDx
F	XC6402FxxxDx

③ Represents product type

MARK	CE/EN FUNCTION	EN/CE LOGIC	PULL UP/DOWN RESISTANCE	VD OUTPUT LOGIC	PRODUCT SERIES
A	Function	High Active	Pull-down Function	Detect L	XC6402xAxxDx
B	Function	High Active	Pull-down Function	Detect H	XC6402xBxxDx
C	Function	High Active	Pull-down Function	Detect L	XC6402xCxxDx
D	Function	High Active	Pull-down Function	Detect H	XC6402xDxxDx
E	Function	High Active	Nonfunctional	Detect L	XC6402xExxDx
F	Function	High Active	Nonfunctional	Detect H	XC6402xFxxDx
H	Function	High Active	Nonfunctional	Detect L	XC6402xHxxDx
K	Function	High Active	Nonfunctional	Detect H	XC6402xKxxDx
L	Function	Low Active	Pull-up Function	Detect L	XC6402xLxxDx
M	Function	Low Active	Pull-up Function	Detect H	XC6402xMxxDx
N	Function	Low Active	Pull-up Function	Detect L	XC6402xNxxDx
P	Function	Low Active	Pull-up Function	Detect H	XC6402xPxxDx
R	Function	Low Active	Nonfunctional	Detect L	XC6402xRxxDx
S	Function	Low Active	Nonfunctional	Detect H	XC6402xSxxDx
T	Function	Low Active	Nonfunctional	Detect L	XC6402xTxxDx
U	Function	Low Active	Nonfunctional	Detect H	XC6402xUxxDx
V	Nonfunctional	-	-	Detect L	XC6402xVxxDx
X	Nonfunctional	-	-	Detect H	XC6402xXxxDx
Y	Nonfunctional	-	-	Detect L	XC6402xYxxDx
Z	Nonfunctional	-	-	Detect H	XC6402xZxxDx

④,⑤ Represents output voltage and detect voltage
ex.)

MARK		OUTPUT VOLTAGE		PRODUCT SERIES
③	④	VROUT (V)	VdOUT (V)	
0	6	1.5	2.8	XC6402xx06Dx

⑥ Represents production lot number

0 to 9, A to Z repeated (G, I, J, O, Q, W excepted)

Note: No character inversion used.

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